HP Z6 G4 Workstation

Overview

HP Z6 G4 Workstation



Front view

- 1. Integrated Front Handle
- 2. Front I/O module options
 - Premium (optional, shown here): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C[™] (Left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
 - Standard: power button, 4 USB 3.1 G1 Type-A (left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
- 3. 2 x 5.25" external bays
- 4. 1 Slim ODD bay



HP Z6 G4 Workstation

QuickSpecs

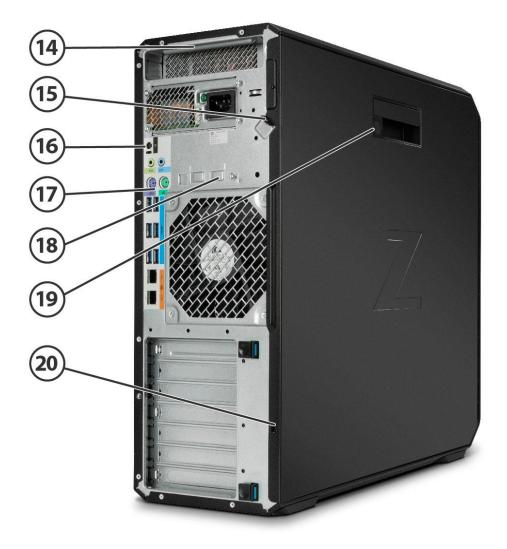
Overview



Internal view

- 5. Power supply: 1000W 90% efficient with 2 graphics power adapters
- 6. 6 DIMM slots: DDR4-2666 Registered RAM
- 7. Intel[®] Xeon[®] processor Scalable family
- 8. 2nd CPU & memory riser connector: adds 2nd CPU socket and (6) DIMM slots
- 9. PCIe slots: 2 PCIe G3 x16, 3 PCIe G3 x4, 1 PCIe G3 x8
- 10. 6 x 6Gb/s SATA ports
- 11. 2 PCIe G3 x4 M.2 for SSDs
- 12. 2 x 2.5"/3.5" internal drive bays
- 13. 2 x 5.25" external drive bays

Overview



Rear view

- 14. Rear handle
- 15. Padlock loop
- 16. Rear power button
- Rear I/O (top to bottom): audio in/out, keyboard/mouse PS/2, 6 USB 3.1 G1 Type-A, 2 x 1GbE LAN ports

- 18. HP Dual Port 10GBase-T NIC module slot (optional)
- 19. Side panel barrel keylock (optional)
- 20. Kensington lock slot

Overview

Form Factor Operating Systems Tower Preinstalled:

- Windows 10 Pro 64 for Workstations¹
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat[®] Enterprise Linux[®] Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat Enterprise Linux Desktop 7.4²
- SUSE Linux Enterprise Desktop 12 SP3²
- Ubuntu 16.04 LTS²

¹Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

²**Notes**: For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

Note: In accordance with Microsoft's support policy, HP does not support the Windows[®] 7 operating system on products configured with Intel[®] 7th Generation and forward processors.

Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Intel® Turbo Boost Technology ¹	Supports Intel® DCPMM Technology ²	TDP (W)
			Intel® Xeo	n® W Processo	ors			
Intel® Xeon® W-3245 processor	16	3.2 GHz	22	2933	YES	4.4, 4.6	NO	205
Intel® Xeon® W-3235 processor	12	3.3 GHz	19.25	2933	YES	4.4, 4.5	NO	180
Intel® Xeon® W-3225 processor	8	3.7 GHz	16.5	2666	YES	4.3, 4.4	NO	160
Intel® Xeon® W-3223 processor	8	3.5 GHz	16.5	2666	YES	4, 4.2	NO	160
		l	ntel® Xeon® S	calable Proce	essors			
Intel® Xeon® Platinum 8280 processor	28	2.7 GHz	38.50	2933	YES	3.3, 4.0	YES	205
Intel® Xeon® Platinum 8260 processor	24	2.4 GHz	35.75	2933	YES	3.1, 3.9	YES	165
Intel® Xeon® Platinum 8180 processor	28	2.5 GHz	38.50	2666	YES	3.2, 3.8	NO	205
Intel® Xeon® Platinum 8160 processor	24	2.1 GHz	33.00	2666	YES	2.8, 3.7	NO	150
Intel® Xeon® Gold 6258R processor	28	2.7 GHz	38.50	2933	YES	4.0, 3.4	YES	205
Intel® Xeon® Gold 6254 processor	18	3.1 GHz	24.75	2933	YES	3.9, 4.0	YES	200
Intel® Xeon® Gold 6252 processor	24	2.1 GHz	35.75	2933	YES	2.8, 3.7	YES	150



Intel® Xeon® Gold 6248R processor	24	3.0 GHz	35.75	2933	YES	4.0, 3.9	YES	205
Intel® Xeon® Gold 6248 processor	20	2.5 GHz	27.50	2933	YES	3.2, 3.9	YES	150
Intel® Xeon® Gold 6246R processor	16	3.4 GHz	35.75	2933	YES	4.1, 4.0	YES	205
Intel® Xeon® Gold 6244 processor	8	3.6 GHz	24.75	2933	YES	4.3, 4.4	YES	150
Intel® Xeon® Gold 6242R processor	20	3.1 GHz	35.75	2933	YES	4.1, 3.8	YES	205
Intel® Xeon® Gold 6242 processor	16	2.6 GHz	22	2933	YES	3.5, 3.9	YES	150
Intel® Xeon® Gold 6240R processor	24	2.4 GHz	35.75	2933	YES	4.0, 3.2	YES	165
Intel® Xeon® Gold 6240Y processor	18	2.6 GHz	24.75	2933	YES	3.3, 3.9	YES	150
Intel® Xeon® Gold 6240 processor	18	2.6 GHz	24.75	2933	YES	3.3, 3.9	YES	150
Intel® Xeon® Gold 6238R processor	28	2.2 GHz	38.5	2933	YES	4.0, 3.0	YES	165
Intel® Xeon® Gold 6230R processor	26	2.1 GHz	35.75	2933	YES	4.0, 3.0	YES	150
Intel® Xeon® Gold 6230 processor	20	2.1 GHz	27.50	2933	YES	2.8, 3.9	YES	125
Intel® Xeon® Gold 6226 processor	12	2.7 GHz	19.25	2933	YES	3.5, 3.7	YES	125
Intel® Xeon® Gold 6152 processor	22	2.1 GHz	30.25	2666	YES	2.8, 3.7	NO	140
Intel® Xeon® Gold 6154 processor	18	3.0 GHz	24.75	2666	YES	3.7, 3.7	NO	200
Intel® Xeon® Gold 6148 processor	20	2.4 GHz	27.50	2666	YES	3.1, 3.7	NO	150
Intel® Xeon® Gold 6146 processor	12	3.2 GHz	24.75	2666	YES	3.9, 4.2	NO	165
Intel® Xeon® Gold 6144 processor	8	3.5 GHz	24.75	2666	YES	4.1, 4.2	NO	150
Intel® Xeon® Gold 6142 processor	16	2.6 GHz	22.00	2666	YES	3.3, 3.7	NO	150
Intel® Xeon® Gold 6140 processor	18	2.3 GHz	24.75	2666	YES	3.0, 3.7	NO	140
Intel® Xeon® Gold 6138 processor	20	2.0 GHz	27.5	2666	YES	2.7, 3.7	NO	125
Intel® Xeon® Gold 6136 processor	12	3.0 GHz	24.75	2666	YES	3.6, 3.7	NO	150
Intel® Xeon® Gold 6134 processor	8	3.2 GHz	24.75	2666	YES	3.7, 3.7	NO	130
Intel® Xeon® Gold 6132 processor	14	2.6 GHz	19.25	2666	YES	3.3, 3.7	NO	140
Intel® Xeon® Gold 6130 processor	16	2.1 GHz	22.00	2666	YES	2.8, 3.7	NO	125
Intel® Xeon® Gold 6128 processor	6	3.4 GHz	19.25	2666	YES	3.7, 3.7	NO	115
Intel® Xeon® Gold 5222 processor	4	3.8 GHz	16.5	2666	YES	3.9, 3.9	YES	105
Intel® Xeon® Gold 5220R processor	24	2.2 GHz	35.75	2666	YES	4.0, 2.9	YES	150



Intel [®] Xeon [®] Gold 5220	18	2.2 GHz	24.75	2666	YES	2.7, 3.9	YES	105
processor Intel® Xeon® Gold 5218R processor	20	2.1GHz	27.5	2666	YES	4.0, 2.9	YES	125
Intel® Xeon® Gold 5218 processor	16	2.3 GHz	22	2666	YES	2.8, 3.9	YES	125
Intel® Xeon® Gold 5215 processor	10	2.5 GHz	13.75	2666	YES	3.0, 3.4	YES	85
Intel® Xeon® Gold 5120 processor	14	2.2 GHz	19.25	2400	YES	2.6, 3.2	NO	105
Intel® Xeon® Gold 5118 processor	12	2.3 GHz	16.50	2400	YES	2.7, 3.2	NO	105
Intel® Xeon® Gold 5115 processor	10	2.4 GHz	13.75	2400	YES	2.8, 3.2	NO	85
Intel® Xeon® Gold 5122 processor	4	3.6 GHz	16.50	2666	YES	3.7, 3.7	NO	105
Intel® Xeon® Silver 4216 processor	16	2.1 GHz	22	2400	YES	2.7, 3.2	NO	100
Intel® Xeon® Silver 4215R processor	8	3.2 GHz	11	2400	YES	4.0, 3.6	YES	130
Intel® Xeon® Silver 4215 processor	8	2.5 GHz	11	2400	YES	3.0, 3.5	YES	85
Intel® Xeon® Silver 4214R processor	12	2.4 GHz	16.5	2400	YES	3.0, 3.5	NO	100
Intel® Xeon® Silver 4214Y processor	12	2.2 GHz	16.5	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4214 processor	12	2.2 GHz	16.5	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4210R processor	10	2.4 GHz	13.75	2400	YES	2.9, 3.2	NO	100
Intel® Xeon® Silver 4210 processor	10	2.2 GHz	13.75	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4208 processor	8	2.1 GHz	11	2400	YES	2.5, 3.2	NO	85
Intel® Xeon® Silver 4116 processor	12	2.1 GHz	16.50	2400	YES	2.4, 3.0	NO	85
Intel® Xeon® Silver 4114 processor	10	2.2 GHz	13.75	2400	YES	2.5, 3.0	NO	85
Intel® Xeon® Silver 4112 processor	4	2.6 GHz	8.25	2400	YES	2.9, 3.0	NO	85
Intel® Xeon® Silver 4110 processor	8	2.1 GHz	11.00	2400	YES	2.4, 3.0	NO	85
Intel® Xeon® Silver 4108 processor	8	1.8 GHz	11.00	2400	YES	2.1, 3.0	NO	85
Intel® Xeon® Silver 3206R processor	8	1.9 GHz	11.00	2133	YES	N/A	NO	85
Intel® Xeon® Bronze 3204 processor	6	1.9 GHz	8.25	2133	YES	N/A	NO	85
Intel® Xeon® Bronze 3106 processor	8	1.7 GHz	11.00	2133	NO	N/A	NO	85
Intel® Xeon® Bronze 3104 processor	6	1.7 GHz	8.25	2133	NO	N/A	NO	85



	All Z6G4 Intel® Xeon® CPUs Feature Intel® vPro™ Technology.
	¹ The specifications shown in this column represent the following: (all core maximum turbo frequency, one core maximum turbo frequency). Processors that do not have turbo functionality are denoted as N/A.
	² Intel [®] Data Center Persistent Memory Modules availability will be announced at a future date.
Available Processors	
Disclaimers	When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.
	Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
Color	Black
Convertibility	Νο
Expansion Slots (see system board section for more details)	Slot 0: Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2 nd CPU riser is installed
	Slot 1: PCI Express Gen3 x4 - CPU with open-ended connector*
	Slot 2: PCI Express Gen3 x16 - CPU
	Slot 3: PCI Express Gen3 x4 - PCH with open-ended connector*
	Slot 4: PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*
	Slot 5: PCI Express Gen3 x16 - CPU
	Slot 6: PCI Express Gen3 x4 - PCH with open-ended connector*
	M.2 Slot 1: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices
	M.2 Slot 2: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices
	* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.
	 M.2 Slot 1: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices M.2 Slot 2: M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices * Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a storage devices



Expansion Bays (see storage section for more details)	 2 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed) 2 external 5.25" bays 3rd and 4th 3.5" HDD each occupy one external bay 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier)
	1 dedicated 9.5mm slim optical disk drive bay
Front I/O	 Base: Power button, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging) Premium (optional): Power button, 1 Headset audio port, 2 USB 3.1 G2 Type C[™], 2 USB 3.1 G1 Type A (1 charging) Optional: SD reader
Internal I/O	1 USB 3.1 G1 (aka USB 3.0) single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port header
Rear I/O	6 USB 3.1 G1 (aka USB 3.0) Type A ports, 2 1Gbe LAN ports (1x supporting Intel® AMT), Audio: 1 Line out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2 keyboard port, 1 Rear power button Optional: 1 serial port (cable up to rear bulkhead)
Interfaces Supported	SD card reader (optional) 6-channel SATA interface (6 @ 6.0 Gb/s) 6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported) USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional)
On-board RAID Support	SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 5 Striped/Parity SATA RAID 10 Striped/Mirrored
Chassis Dimensions (H x W x D)	H: 17.5" (445mm) W: 6.65" (169mm) D: 18.3" (465mm)
Packaged Dimensions	H: 24" (610mm) W: 12.3" (313mm) D: 23.3" (593mm)
Rack Dimensions	4U
Weight	Exact weights depend upon configuration (System weight only). Minimum: 13.1 kg (29 lbs.) Standard: 13.6 kg (30.1 lbs.) Maximum: 23.9 kg (52.7 lbs.)
Temperature	Operating: 5° to 35°C (40° to 95°F) Non-operating: -40° to 60°C (-40° to 140°F)
	Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase
Humidity	Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb
Maximum Altitude (non- pressurized)	Operating: 3,048m (10,000ft) Non-operating: 9,144m (30,000ft)



Overview					
	Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase				
Power Supply	1000 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2X 6-pin graphics power cables (graphics power cables are 6/8-pin convertible)				
	The Z6 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf				
Workstation ISV Certifications	See the latest list of certifications at http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html				

Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number ¹	Support Notes
Intel® Xeon® W-3200 Series CPU				
Intel® Xeon® W-3245 3.2 2933 16C processor	Y	Ν		
Intel® Xeon® W-3235 3.3 2933 12C processor	Y	Ν		
Intel® Xeon® W-3225 3.7 2666 8C processor	Y	Ν		
Intel® Xeon® W-3223 3.5 2666 8C processor	Y	Ν		
Intel® Xeon® Scalable CPU				
Intel® Xeon® Platinum 8280 processor	Y	Ν		1
Intel® Xeon® Platinum 8260 processor	Y	Ν		1
Intel [®] Xeon [®] Platinum 8180 processor	Y	Ν		
Intel [®] Xeon [®] Platinum 8160 processor	Y	Y	1XM35AA	
Intel [®] Xeon [®] Gold 6258R processor	Y	Ν		
Intel [®] Xeon [®] Gold 6254 processor	Y	Ν		1
Intel [®] Xeon [®] Gold 6252 processor	Y	Y	5YT07AA	1
Intel [®] Xeon [®] Gold 6248R processor	Y	Ν		
Intel [®] Xeon [®] Gold 6248 processor	Y	Y	5YT06AA	1
Intel [®] Xeon [®] Gold 6246R processor	Y	Ν		
Intel [®] Xeon [®] Gold 6244 processor	Y	Y	5YT05AA	1
Intel [®] Xeon [®] Gold 6242R processor	Y	Ν		1
Intel [®] Xeon [®] Gold 6242 processor	Y	Y	5YT04AA	1
Intel [®] Xeon [®] Gold 6240R processor	Y	Ν		1
Intel [®] Xeon [®] Gold 6240Y processor	Y		5YT03AA	1
Intel [®] Xeon [®] Gold 6240 processor	Y	Y	5YT02AA	1
Intel [®] Xeon [®] Gold 6238R processor	Y	Ν		1
Intel [®] Xeon [®] Gold 6230R processor	Y	Y	9VA87AA	1
Intel [®] Xeon [®] Gold 6230 processor	Y	Y	5YS99AA	1
Intel [®] Xeon [®] Gold 6226R processor	Y	Y	9VA85AA	1
Intel [®] Xeon [®] Gold 6226 processor	Y	Y	5YS98AA	1
Intel [®] Xeon [®] Gold 6152 processor	Y	Y	1XM36AA	
Intel [®] Xeon [®] Gold 6154 processor	Y	Ν		
Intel [®] Xeon [®] Gold 6148 processor	Y	Y	1XM37AA	
Intel [®] Xeon [®] Gold 6146 processor	Y	Ν		
Intel [®] Xeon [®] Gold 6144 processor	Y	Y	3BA12AA	
Intel [®] Xeon [®] Gold 6142 processor	Y	Y	1XM38AA	
Intel [®] Xeon [®] Gold 6140 processor	Y	Y	1XM40AA	
Intel [®] Xeon [®] Gold 6138 processor	Y	Y	3GG95AA	
Intel [®] Xeon [®] Gold 6136 processor	Y	Y	1XM39AA	
Intel® Xeon® Gold 6134 processor	Y	Y	1XM41AA	
Intel [®] Xeon [®] Gold 6132 processor	Y	Y	1XM42AA	
Intel® Xeon® Gold 6130 processor	Y	Y	1XM43AA	
Intel [®] Xeon [®] Gold 6128 processor	Y	Y	1XM44AA	
-	V	V		
Intel [®] Xeon [®] Gold 5222 processor	Y	Y	5YS97AA	1



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HP Z6 G4 Workstation

QuickSpecs

Supported Components

Intel [®] Xeon [®] Gold 5220 processor	Y	Y	5YS96AA	1
Intel [®] Xeon [®] Gold 5218R processor	Y	Y	9VA83AA	1
Intel® Xeon® Gold 5218 processor	Y	Y	5YS95AA	1
Intel [®] Xeon [®] Gold 5215 processor	Y	Y	5YS94AA	1
Intel [®] Xeon [®] Gold 5120 processor	Y	Y	1XM47AA	
Intel [®] Xeon [®] Gold 5118 processor	Y	Y	1XM45AA	
Intel [®] Xeon [®] Gold 5115 processor	Y	Y	1XM46AA	
Intel [®] Xeon [®] Gold 5122 processor	Y	Y	4MB89AA	
Intel [®] Xeon [®] Gold 4216 processor	Y	Y	5YS93AA	
Intel [®] Xeon [®] Gold 4215 processor	Y	Y	5YS92AA	1
Intel [®] Xeon [®] Gold 4214R processor	Y	Y	8BC96AA	1
Intel [®] Xeon [®] Gold 4214Y processor	Y	Y	5ZB33AA	
Intel [®] Xeon [®] Gold 4214 processor	Y	Y	5YS91AA	
Intel [®] Xeon [®] Gold 4210R processor	Y	Y	8BD02AA	
Intel [®] Xeon [®] Gold 4210 processor	Y	Y	5YS90AA	
Intel [®] Xeon [®] Gold 4208 processor	Y	Y	5YS89AA	
Intel [®] Xeon [®] Silver 4116 processor	Y	Y	1XM48AA	
Intel [®] Xeon [®] Silver 4114 processor	Y	Y	1XM49AA	
Intel [®] Xeon [®] Silver 4112 processor	Y	Y	1XM50AA	
Intel [®] Xeon [®] Silver 4110 processor	Y	Y	3GG94AA	
Intel [®] Xeon [®] Silver 4108 processor	Y	Y	1XM51AA	
Intel [®] Xeon [®] Bronze 3206R processor	Y	Y	8BC93AA	
Intel [®] Xeon [®] Gold 3204 processor	Y	Y	5YS88AA	
Intel [®] Xeon [®] Bronze 3106 processor	Y	Y	1XM52AA	
Intel [®] Xeon [®] Bronze 3104 processor	Y	Y	1XM53AA	

¹ Options kits available for second processor upgrade.

Disclaimers: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Note 1: Intel® DCPMM® (Data Center Persistent Memory) Supported.

Monitors / Displays		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Z Display Z22n G2		Y	1JS05AA	
	HP Z Display Z23n G2		Y	1JS06AA	
	HP Z Display Z24i G2		Y	1JS08AA	
	HP Z Display Z24n G2		Y	1JS09AA	
	HP Z Display Z24nf G2		Y	1JS07AA	
	HP Z Display Z27n G2		Y	1JS10AA	
	HP Z Display Z27s (4K display)		Y	J3G07AA	



Supported Components

Supported by all operating systems available from HP Screen size measured diagonally

Storage / Hard Drives

SAS Hard Drives	SAS Hard Drives for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 300GB 15k SAS SFF NOTE: SAS controller add-in card required	Y	Y	L5B74AA	

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200RPM 6Gb/s 3.5" HDD	Y	Y	LQ036AA	
	500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5" HDD	Y	Y	D8N29AA	
	1TB SATA 7200RPM 3.5" HDD	Y	Y	LQ037AA	
	1TB SATA 7200RPM Ent 3.5" HDD	Y	Y	WOR10AA	
	2TB SATA 7200RPM HDD	Y	Y	QB576AA	
	2TB SATA 7200RPM HDD SMR				
	4TB SATA 7200RPM Ent 3.5" HDD	Y	Y	K4T76AA	
	6TB SATA 7200RPM Ent 3.5" HDD	Y	Y	3DH90AA	
	NOTES:				

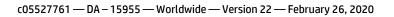
Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0 TB; maximum system HDD storage: 16.0TB



Supported Components

SATA Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Solid State Drives (SSDs) for Workstations				
	HP 256GB SATA SSD	Y	Y	A3D26AA	
	HP 512GB SATA SSD	Y	Y	D8F30AA	
	HP 1TB SATA SSD	Y	Y	F3C96AA	
	HP 2TB SATA SSD	Y	Y	Y6P08AA/AT	
	HP 256GB SATA SED OPAL2 SSD	Y	Y	G7U67AA	
	HP 512GB SATA SED OPAL2 SSD	Y	Y	N8T26AA	
	HP 240GB SATA Enterprise SSD	Y	Y	T3U07AA	
	HP 480GB SATA Enterprise SSD	Y	Y	T3U08AA	

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	PCIe SSDs for HP Workstations				
	HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit	Y	Y	1PD56AA	4
	HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit	Y	Ŷ	1PD57AA/AT	4
	HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit	Y	Y	1PD58AA	4
	HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit	Y	Y	1PD59AA/AT	
	HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit	Y	Y	1PD60AA	
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit	Y	Y	1PD61AA	
	HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit	Y	Y	ЗКРЗ9АА	
	HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit	Ν	Ν	EOL	4
	HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit	Ν	Ν	EOL	4
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Kit	Y	Y	6YT76AA	
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Module	Y	Y	6YT79AA	
	HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	Y	Y	8PE68AA	3
	HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	Y	Y	8PE69AA	3
	HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	Y	Y	8PE70AA	3
	HP 256GB M.2 2280 PCIe NVMe TLC SSD Module	Ν	Y	8PE62AA	2
	HP 512GB M.2 2280 PCIe NVMe TLC SSD Module	Ν	Y	8PE63AA	2
	HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2 Module	Ν	Y	8PE64AA	2
	HP Z Turbo Drive Dual Pro				
	HP Z Turbo Drive Dual Pro 256GB TLC SSD	Y	Y	4YF60AA	3
	HP Z Turbo Drive Dual Pro 512GB TLC SSD	Y	Y	4YF61AA	3
	HP Z Turbo Drive Dual Pro 1TB TLC SSD	Y	Y	4YF62AA	3
	HP Z Turbo Drive Dual Pro 2TB TLC SSD	Y	Y	4YF63AA	3
	HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Y	Y	8PE74AA	3
	HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Y	8PE75AA	3





Supported Components

HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Y	Y	8PE76AA	3
HP Z Turbo Drive Quad Pro				
HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD	Y	Y	4YZ38AA	1
HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD	Y	Y	4YZ39AA	1
HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD	Y	Y	4YZ40AA	1
HP Z Turbo Drive Quad Pro 2x2TB PCIe TLC SSD	Y	Y	3KP42AA	
HP Z Turbo Drive Quad Pro 256GB SSD module	Ν	Y	N2N00AA	2
HP Z Turbo Drive Quad Pro 512GB SSD module	Ν	Y	N2N01AA	2
HP Z Turbo Drive Quad Pro 1TB SSD module	Ν	Y	T9J00AA	2
HP Z Turbo Drive Quad Pro 2TB SSD module	Ν	Y	3KP43AA	
Intel® 905p Series SSD (Opatane SSD)				
Intel® Optane SSD 905p 280GB AiC**	Y	Y	2SC47AA	
Intel® Optane SSD 905p 480GB AiC**	Y	Y	2SC48AA	
Intel® Optane SSD 905p 380GB M.2 SSD Module	Y	Y	6LA66AA	

Note 1: Dual M.2 SSD modules plus carrier and heat sink Note 2: M.2 SSD module only, for Quad Pro or Dual Pro carrier Note 3: Single M.2 SSD module plus dual carrier and heat sink Note 4: These M.2 SSD kits and module are End of Life and no longer available. ** PCIe card installed in standard PCIe x4 slot

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SAS Controller				
	MicroSemi SmartHBA2100-4i4e SAS Controller	Y	Y	1FV90AA	

Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported # of cards
Graphics Cable Adapters	_				
HP DisplayPort to VGA Adapter	Y	Y	AS615AA		
HP DisplayPort to HDMI Adapter	Y	Y	K2K92AA		
HP DisplayPort to Dual Link DVI Adapter	Y	Y	NR078AA		1
HP DisplayPort to DVI-D Adapter	Y	Y	FH973AA		1
HP DisplayPort to DVI-D Adapter (2-pack)	Y	Ν			1
HP DisplayPort to DVI-D Adapter (4-pack)	Y	Ν			1
HP DisplayPort to DVI-D Adapter (6-pack)	Y	Ν			1
NVIDIA [®] SLI 3-slot Graphics Connector	Y	Y	2YY85AA		1
Entry 3D					
NVIDIA [®] Quadro [®] P400 2GB Graphics	Y	Y	1ME43AA		2
NVIDIA [®] Quadro [®] P620 2GB Graphics	Y	Y	3ME25AA		2
AMD FirePro™ W2100 2GB Graphics	Y	Y	J3G91AA		2



Supported Components

Mid-range 3D				
NVIDIA [®] Quadro [®] P1000 4GB Graphics	Y	Y	1ME01AA	3
NVIDIA [®] Quadro [®] P2000 5GB Graphics	Y	Y	1ME41AA	2
NVIDIA [®] Quadro [®] P2200 5GB Graphics	Y	Y	6YT67AA	2
AMD Radeon™ Pro WX 3100 4GB Graphics	Y	Y	2TF08AA	2
AMD Radeon™ Pro WX 3200 4GB Graphics	Y	Y	6YT68AA	2
AMD Radeon™ Pro WX 4100 4GB Graphics	Y	Y	ZOB15AA	2
High End 3D				
NVIDIA [®] Quadro [®] P4000 8GB Graphics	Y	Y	1ME40AA	2
NVIDIA [®] Quadro RTX 4000 8GB Graphics	Y	Y	5JV89AA	2
AMD Radeon™ Pro WX 7100 8GB Graphics	Y	Y	ZOB14AA	2
Ultra High-End 3D				
NVIDIA [®] Quadro [®] GP100 16GB Graphics	Y		1ZE81AA	1
NVIDIA [®] Quadro [®] P5000 16GB Graphics	Y	Y	ZOB13AA	2
NVIDIA [®] Quadro [®] P6000 24GB Graphics	Y	Y	ZOB12AA	1
NVIDIA [®] Quadro RTX 5000 16GB Graphics	Y	Y	5JH81AA	1
NVIDIA [®] Quadro RTX 6000 24GB Graphics	Y	Y	5JH80AA	1
NVIDIA [®] Quadro RTX 8000 48GB Graphics	Y	Y	6NB51AA	1
AMD Radeon™ Pro WX 9100 16GB Graphics	Y	Y	2TF01AA	1
NVIDIA [®] Quadro [®] Sync II	Y	Y	1WT20AA	

Memory	СТО	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	DDR4-2666 ECC Registered DIMMs				
	8GB (1x8GB) DDR4-2666 ECC Reg Memory	Y	Y	1XD84AA	1
	16GB (1x16GB) DDR4-2666 ECC Reg Memory	Ν	Y	1XD85AA	1
	32GB (1x32GB) DDR4-2666 ECC Reg Memory	Ν	Y	1XD86AA	1
	DDR4-2933 ECC Registered DIMMs				
	8GB (1x8GB) DDR4-2933 ECC Reg Memory	Y	Y	5YZ56AA	1
	16GB (1x16GB) DDR4-2933 ECC Reg Memory	Ν	Y	5YZ54AA	1
	32GB (1x32GB) DDR4-2933 ECC Reg Memory	Ν	Y	5YZ55AA	1
	64GB (1x64GB) DDR4-2399 ECC Reg Memory	Ν	Y	5YZ57AA	1

NOTE 1: For details on the supported memory configurations on the HP Z6 G4 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 6 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

With single-processor configurations, 6 DIMM slots are available. 6 additional DIMM slots are available with the 2nd CPU & Memory Module.

The CPUs determine the speed at which the memory is clocked. If a 2400MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.



Supported Components

The Z6 G4 is designed to work ONLY with DDR4 memory. The system will not work with DDR3 memory.

NOTE 2: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxAT) HP memory part numbers designated as "2666" will be transitioned to use "2933" speed memory components. This does not affect HP part number availability nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" have been tested to work with "2933" memory and are fully-supported by HP under standard support terms.

NVDIMM Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel® Optane™ DC Persistent Memory (DCPMM)				
	128GB (1x128GB) DC Persistent Memory Module	Y	Ν		1,2
	256GB (2x128GB) DC Persistent Memory Configuration	Y	Ν		1
	512GB (4x128GB) DC Persistent Memory Configuration	Y	Ν		1,3

NOTE 1: Supported only with Xeon 82xx, 62xx, 52xx and 4215 processors.

- a. Available as factory configured in Memory Mode or Storage Mode.
 - i. Microsoft Configured Memory Mode will be available in CQ1 2020
- b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- c. Operating System Support:
 - i. Windows 10 Pro 64 for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- d. Detailed setup, security and support information may be found in the <u>Intel[®] Optane[™] DC Persistent</u> <u>Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation</u> white paper.
- e. DCPMM solutions require additional DRAM memory to be included in the solution:
 - i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
 - ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 i. Z8 G4 Note: "M" processors support a total memory limit < =2TB per processors or 4TB per dual
 - processor system
- **NOTE 2:** Option Kit available in CQ1-2020.

NOTE 3: Requires 2^{nd} processor option.

Multimedia and Audio Devices

HP Z6 G4 Workstation

Supported Components

Multimedia and Audio Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
Integrated Realtek HD ALC221 Audio	Y	Ν			

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives				
HP 9.5mm Slim Blu Ray Disc Writer	Y	Y	K3R65AA	
HP 9.5mm Slim DVD ROM	Y	Y	K3R63AA	
HP 9.5mm Slim DVD Writer	Y	Y	K3R64AA	
HP Half Height Optical Drives				
HP HH DVD Writer (16X RW DVD-R)	Ν	Y	4AR67AA	
HP SD Card Reader				
HP SD 4 Card Reader	Y	Y	YOL99AA	
HDD Frame/Carriers				
HP DX175 Removable HDD Carrier	Ν	Y	1ZX72AA	
HP DX175 Removable HDD Frame/Carrier	Ν	Y	1ZX71AA	
NVMe Frame/Carrier				
HP QX310 Removable NVMe Frame/Carrier w/PCIe card	Y	Ν	8GQ89AA/AT	
HP QX310 Removable Carrier only	Ν	Y	8GQ91AA/AT	

Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Option Kit Part Factory Option Configured Kit Number Support Notes HP i350-T2 PCIe Dual Port Gigabit NIC Υ Υ V4A91AA Intel[®] i350-T4 PCIe 4-Port Gigabit NIC γ W8X25AA Ν Intel® Ethernet I210-T1 PCIe x1 Gb NIC Υ Υ E0X95AA Aquantia® NBASE-T 5GbE PCIe NIC Ν γ 1PM63AA Y γ HP Dual Port 10GBase-T NIC Module 1QL49AA Intel[®] 8265 802.11 a/b/g/n/ac + BT PCIe WLAN Ν γ 1QL48AA

Networking and Communications



Supported Components

Intel® X550-T2 10GbE Dual Port NIC	Y	Y	1QL46AA	
Intel [®] X710-DA2 10GbE SFP+ Dual Port NIC	Y	Y	1QL47AA	1
HP 10GbE SFP+ SR Transceiver	Y	Y	C3N53AA	
Intel® Wi-Fi 6 AX200 & BT PCIe	Ν	Y	7CE01AA	1

Note 1: Windows 7 is NOT supported

Racking and Physical Security



Supported Components

Racking and Physical Security

Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
Y	Ν			
Y	Ν			
Ν	Y	2HW42AA		
Ν	Y	T1A62AA		
	Configured Y Y N	Configured Kit Y N Y N N Y	Factory ConfiguredOption KitKit Part NumberYNYNYNNY2HW42AA	Factory ConfiguredOption KitKit Part NumberSupport NotesYNYNYNNYNY2HW42AA

Input Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Wireless Business Slim Keyboard and Mouse	Y	Y	N3R88AA	
Business Slim PS/2 Wired Keyboard	Y	Y	N3R86AA	
USB Business Slim Wired Keyboard	Y	Y	N3R87AA	
USB Premium Wired Keyboard	Y	Y	Z9N40AA	
USB Wired SmartCard CCID Keyboard	Y	Y	E6D77AA	
3Dconnexion CADMouse	Y	Y	M5C35AA	
HP Optical USB Mouse	Y	Y	QY777AA	
HP PS/2 Mouse	Y	Y	QY775AA	
HP USB Hardened Mouse	Y	Y	P1N77AA	

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP ENERGY STAR [®] Certified Configuration	Y			
HP Z Premium Front I/O 2xUSB-A 2xUSB-C	Y	Y	1XM32AA	
HP Z6 G4 Memory Cooling Solution	Y	Y	2HW44AA	Note 1
HP Internal USB Port Kit	Ν	Y	EM165AA	Note 2
HP eSATA 2 port PCI Bulkhead Kit	Y	Y	GM110AA	
HP Serial Port Adapter	Y	Y	PA716A	
HP Workstation Mouse Pad	Y			

Note 1: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

Note 2: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Software		Option Kit			
		Factory Configured	Option Kit	Part Number	Support Notes
	Sobey Video Editing SW	Y	Ν		



Supported Components

SW HP RGS for Z	Y	Ν
HP Sure Start Gen3	Y	Ν
HP Performance Advisor	Y	Ν



Supported Components

Operating Systems

HP Z6 G4 Workstation

	Support Notes
Windows 10 Pro 64	
Windows 7 Professional 64-bit	
Windows 10 Downgrade to Windows 7	
HP Linux [®] Installer Kit	Note 2
Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr)	Note 1
NOTE 1: This second OS must be ordered with the HP Linux [®] Installer Kit as the first	0S.

NOTE 2: includes drivers for 64-bit OS versions of RHEL 6 & 7, SUSE Linux[®] Enterprise Desktop 11 and Ubuntu 14.04. For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

For detailed Windows 7 OS hardware support information see http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf. Intel Xeon® SP Processors: Platinum 8100, Gold 6100, Gold 5100, Silver 4100, & Bronze 3100 Family support Microsoft Windows 7 Professional 64-bit.



System Technical Specifications

System Board

System Board Form Factor	Main System Board: 24 x 31 cm 9.6 x 12.2 inches
	2nd CPU/Memory Board (optional):
	14.9 x 29.2 cm
	5.85 x 11.50 inches
Processor Socket	FCLGA3647 (Socket P)
	1st CPU on system board
	2nd CPU on optional 2nd CPU/Memory Module
CPU Bus Speed	UPI: Up to 10.4GT/second, depending on processor
Chipset	Intel® C622 Chipset
Super I/O Controller	Nuvoton SIO15
Memory Expansion Slots	6 on system board (CPUO) + 6 on optional 2nd CPU/Memory Module (CPU1)
Memory Type Supported	DDR4 R-DIMM (Registered), ECC: 8GB, 16GB, 32GB, and 64GB
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	2133MT/s, 2400MHz, 2666MT/s, and 2933MT/s

Available Memory Configurations:

			Single P	ocessor				
			CP	U O				
_		Top Slots Bottom Slots						
Capacity	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6	Perf Rating	
8 GB	8 GB						Fair	
16 GB	8 GB					8 GB	Good	
24 GB	8 GB	8 GB	8 GB				Better	
32 GB	8 GB		8 GB	8 GB		8 GB	Better	
32 UD	16 GB					16 GB	Good	
48 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	Best	
40 UD	16 GB	16 GB	16 GB				Better	
64 GB	16 GB		16 GB	16 GB		16 GB	Better	
04 UD	32 GB					32 GB	Good	
96 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	Best	
90 GD	32 GB	32 GB	32 GB				Better	
128 GB	32 GB		32 GB	32 GB		32 GB	Better	
192 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	Best	
256 GB	64 GB		64 GB	64 GB		64 GB	Better	
384 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	Best	

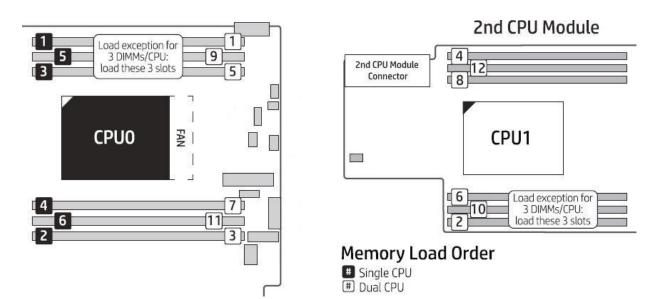


						Dual Pr	ocessor	i i					
			CP	U 0			CPU 1						
	T	op Slot	s	Bo	ttom Sl	ots	٦	op Slot	S	Bo	Bottom Slots		
Capacity	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	Rating
16 GB	8 GB						8 GB						Fair
32 GB	8 GB					8 GB	8 GB					8 GB	Good
48 GB	8 GB	8 GB	8 GB				8 GB	8 GB	8 GB				Better
64 GB	8 GB		8 GB	8 GB		8 GB	8 GB		8 GB	8 GB		8 GB	Better
04 UD	16 GB					16 GB	16 GB					16 GB	Good
96 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	Best
90 GD	16 GB	16 GB	16 GB				16 GB	16 GB	16 GB				Better
128 GB	16 GB		16 GB	16 GB		16 GB	16 GB		16 GB	16 GB		16 GB	Better
128 GD	32 GB					32 GB	32 GB					32 GB	Good
192 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	Best
192 UD	32 GB	32 GB	32 GB				32 GB	32 GB	32 GB				Better
256 GB	32 GB		32 GB	32 GB		32 GB	32 GB		32 GB	32 GB		32 GB	Better
230 UD	64 GB					64 GB	64 GB					64 GB	Best
384 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	Better
384 UD	64 GB	64 GB	64 GB				64 GB	64 GB	64 GB				Best
512 GB	64 GB		64 GB	64 GB		64 GB	64 GB		64 GB	64 GB		64 GB	Fair
768 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	Good

System Technical Specifications

Memory Loading Order:

Load Order for Single and Dual Processor Configuration



Supports up to 768 GB DDR4-2933 ECC RAM* (transfer rates up to 2933MT/s) and 384 GB DDR4-2666 ECC **Maximum Memory** RAM (transfer rates up to 2666MT/s). **Memory Configuration** Only Registered ECC DIMMs are supported. (Supported)

Do not install memory modules into memory slots if corresponding processor is not installed.

Dual processor configurations with memory modules installed for only one processor is not supported.

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible Notes system memory is 192GB

*768 GB configuration requires 2 CPUs configuration.

NVDIMM Memory

Intel[®] Optane[™] DC Persistent Memory is available factory configured in the following capacities:

- 128GB (1x128GB) Single Processor Configuration
- 256GB (2x128GB) Single Processor Configuration
- 512GB (4x128GB) Dual Processor Configuration •

NOTES:

- Supported only with Xeon 82xx, 62xx, 52xx and 4215 processors. 1.
 - a. Available as factory configured in Memory Mode or Storage Mode.
 - i. Microsoft Configured Memory Mode will be available in CQ1 2020
 - b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
 - c. Operating System Support:
 - i. Windows 10 Pro 64 for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
 - d. Detailed setup, security and support information may be found in the Intel[®] Optane[™] DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation white paper.
 - DCPMM solutions require additional DRAM memory to be included in the solution: e.



System Technical Specifications

- i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
- ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
- iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. Z8 G4 Note: "M" processors support a total memory limit < =2TB per processors or 4TB per dual processor system
- 2. Option Kit available in CQ1-2020.
- 3. Requires 2nd processor option.

PCI Express Connectors Slot 0:

Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

Supported Drive Interfaces	SATA	6 SATA @6Gb/s, supports RAID 0, 1, 5, & 10
	Serial Attached SCSI	Requires Optional PCIe card
	Factory Configured RAID	SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored Notes: Factory integrated Intel® SATA RAID is Microsoft Windows only.



	External SATA (eSATA)	Supported on all SATA ports configurable with optional eSATA* cable kit * hot plug / hot swap not supported with eSATA
Network Controller	Integrated Intel® I219LM GbE LAN	Supports the following management functionalities: Intel® AMT11.2, TXT, DASH 1.1, WOL, VLAN, and PXE 2.1
	Integrated Intel X722 for 1GbE	Data rates supported: 1000 Mb/s Compliance IEEE 802.1as/1588v2, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3x Up to 16 UDP/TCP programmable filters Bus architecture: PCIe 3.0 UEFI and PXE Boot ROM support Intel iWARP Support (RDMA) Network transfer rates: 1000BASE-T (full-duplex) 2000 Mb/s Management capabilities: WOL (Excluding Max Power Savings), auto MDI crossover, PXE, Quad Hash filtering, RSS, Advanced cable diagnostics
USB Connector(s)	Front	 Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Capability) Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-C[™] (Left-most Port has Charging Capability) Charging Ports provide 1.5 Amps @ 5 Volts Standard USB Type A Ports provide 900mA @ 5 Volts USB Type C Ports provide 3 Amps @ 5 Volts and adhere to the Power Delivery 3.0 specification.
	Rear	6 USB 3.1 G1 Type A
	Internal	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header
Integrated Graphics	Internal No	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header
Integrated Graphics HD Integrated Audio		1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header
HD Integrated Audio Flash ROM	No Realtek ALC221 Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header
HD Integrated Audio Flash ROM CPU Fan Header	No Realtek ALC221 Yes One for each CPU socke	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header	No Realtek ALC221 Yes One for each CPU socke r Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header	No Realtek ALC221 Yes One for each CPU socke r Yes Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder -	No Realtek ALC221 Yes One for each CPU socke r Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header	No Realtek ALC221 Yes One for each CPU socke r Yes Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header et
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted	No Realtek ALC221 Yes One for each CPU socke r Yes Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list:
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header	No Realtek ALC221 Yes One for each CPU socke r Yes Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list:
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header Clear Password Jumper	No Realtek ALC221 Yes One for each CPU socke r Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list:
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header Clear Password Jumper Serial Port	No Realtek ALC221 Yes One for each CPU socke r Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list:
HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power LED & Hard Drive LED Header Clear Password Jumper	No Realtek ALC221 Yes One for each CPU socke r Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products https://trustedcomputi Yes Yes	1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1 x USB 2.0 dual-port header et • Certified list:



System Technical Specifications

Hood Lock HeaderYesHood Sensor HeaderYesMemory Fan1 Memory Fan Header per CPUAUX IN (audio)No

Z6 Required Power Supply Info					
Power Supply	1000W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)				
Operating Voltage Range	90–269 V	AC			
Rated Voltage Range	100-127 VAC 118 VAC 200-240 VAC				
Rated Line Frequency	50-60 Hz	400 Hz			
Operating Line Frequency Range	47-66 Hz	393-407 Hz			
Rated Input Current	12 A @ 100-127 VAC 6.3 A @ 200-240 VAC	12A @ 118 VAC			
Heat Dissipation (Configuration and software dependent)	Typical = 2467 Maximum = 417				
Power Supply Fan	80x25 mm varia	ble speed			
ENERGY STAR [®] Qualified (Configuration dependent)	Yes	Yes			
80 PLUS® Compliant	Yes, 90% Eff The Z6 G4 1000W power supply efficien https://plugloadsolutions.com 1K0P1A_1000W_ECOS%2	cy report can be found at this link: n/psu_reports/HP_D15-			
FEMP Standby Power Compliant @115V (<1W in S5 – Power Off)	Yes				
EuP Compliant @ 230V (<0.5 W in S5 – Power Off)	Yes				
CECP Compliant @ 220V (<4W in S3 – Suspend to RAM)	Yes; Configuration	dependent			
Power Consumption in sleep mode (as defined by ENERGY STAR®) – Suspend to RAM (S3) (Instantly Available PC)	<= 20W	I			
Built-in Self Test LED	Yes				
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes				
Sensor Header	Integrated in Front User Interface (Power 9 Speaker) Cable	Switch, Power LED, HDD LED,			
Integrated Gigabit Ethernet Clear CMOS Button	Integrated Intel® I219LM GbE LAN Yes				



System Technical Specifications

System Configuration

Example Z6 G4	Processor	1x Intel Xeon 3104 (Six-core)								
Configuration #1	Memory	1x 8GB DDR4-2666 (Registered DIMM)								
	Graphics	1x NVIDIA Quadro P400								
	Disks / Optical	1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA								
	Power Supply	1000W 90% c	ustom PSU							
	Other	NA								
115 VAC 230 VAC 10							VAC			
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled			
	Windows Idle (SO)	54	.109	54.	586	54.	906			
	Windows Busy Typ(SO)	94.256		94.	94.275		94.043			
	Windows Busy Max (SO)	95.992		95.268		95.643				
	Sleep (S3)	6.219	6.205	6.319	6.306	6.334	6.239			
	Off (S5)	3.354	3.343	3.521	3.341	3.350	3.342			
	Zero Power Mode (ErP)	0.209		0.388		0.195				
		115	5 VAC	230	VAC	100	VAC			
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled			
(Btu/hr)	Windows Idle (SO)	184	1.619	186.247		187.339				
	Windows Busy Typ(SO)	321	.601	321	.666	320.875				
	Windows Busy Max (SO)	327	7.524	325	.054	326	.334			
	Sleep (S3)	21.219	21.171	21.561	21.516	21.611	21.287			
	Off (S5)	11.444	11.406	12.014	11.399	11.430	11.403			
	Zero Power Mode (ErP)	0.	713	1.3	323	0.6	565			

Example Z6 G4	Processor	1x Intel Xeon 4108 (Eight-core)								
Configuration #2	Memory	4x 8GB DDR4-2666 (Registered DIMM)								
	Graphics	1x NVIDIA Quadro P2000								
	Disks / Optical	2x 1TB SATA 7200 ; 1x Slim DVDRW SATA								
	Power Supply	1000W 90% custom PSU								
	Other	ΝΑ								
Energy Consumption		115 VAC 230 VAC					VAC			
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled			
	Windows Idle (SO)	61.661		61.531		61.354				
	Windows Busy Typ(SO)	168.665		167.375		166.535				
	Windows Busy Max (SO)	166	5.097	163.682		169.674				
	Sleep (S3)	7.231	7.177	7.229	7.217	7.324	7.248			
	Off (S5)	3.376	3.366	3.527	3.512	3.354	3.350			
	Zero Power Mode (ErP)	0.211		0.386		0.195				
		115 VAC		230 VAC		100 VAC				
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled			
(Btu/hr)	Windows Idle (SO)	210.387		209.944		209.340				



Windows Busy Typ(SO)	575	5.485	571.	.084	568	.217
Windows Busy Max (SO)	576	5.959	575.	.543	578	.928
Sleep (S3)	24.672	24.488	24.665	24.624	24.989	24.730
Off (S5)	11.519	11.484	12.034	11.983	11.443	11.430
Zero Power Mode (ErP)	0.	720	1.3	17	0.6	65

Example Z6 G4	Processor	1x Intel Xeon	6136 (Twelve-c	ore)				
Configuration #3	Memory	6x 8GB DDR4	-2666 (Register	red DIMM)				
ENERGY STAR	Graphics	1x NVIDIA Qua	adroP4000					
QUALIFIED	Disks/Optical	2x 1TB SATA	7200 ; 1x Slim [OVDRW SATA				
	Power Supply	1000W 90% c	ustom PSU					
1	Other	NA						
Energy Consumption		115	5 VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
1	Windows Idle (SO)	79	.074	79.	109	79.	938	
1	Windows Busy Typ(SO)		324.975		317.991		327.451	
1	Windows Busy Max (SO)	328.268		320.296		329.668		
1	Sleep (S3)	7.847	7.756	7.878	7.826	7.931	7.852	
1	Off (S5)	3.353	3.348	3.535	3.489	3.373	3.355	
1	Zero Power Mode (ErP)	0.206		0.386		0.196		
		115	5 VAC	230	VAC	100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (SO)	269	9.801	269	.920	272	.748	
	Windows Busy Typ(SO)	110	8.815	1084.985		1117.262		
	Windows Busy Max (SO)	112	0.051	1092	2.850	1124	1.827	
1	Sleep (S3)	26.774	26.463	26.880	26.702	27.061	26.791	
1	Off (S5)	11.441	11.426	12.061	11.904	11.509	11.447	
1	Zero Power Mode (ErP)	0.	703	1.3	817	0.6	69	

Example Z6 G4	Processor	2x Intel Xeon 8160 (Dual 24-core)						
Configuration #4	Memory	12x 32GB DDF	84-2666 (Regi	stered DIMM)				
	Graphics	2x NVIDIA Qua	2x NVIDIA Quadro P5000					
	Disks / Optical	4x 2TB SATA 7	4x 2TB SATA 7200 ; 1x Slim DVDRW SATA					
	Power Supply	1000W 90% c	1000W 90% custom PSU					
	Other	NA						
Energy Consumption		115 VAC		230 VAC		100 VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
	Windows Idle (SO)	112.	388	115	.635	112	.102	
	Windows Busy Typ(SO)	512.	368	490.165		526.905		
	Windows Busy Max (SO)	698.	548	673	.465	706	.461	
1	Sleep (S3)	14.208	13.833	14.698	14.487	15.176	13.886	



System Technical Specifications

	Off (S5)	3.511	3.418	3.575	3.570	3.509	3.412
	Zero Power Mode (ErP)	0.2	87	0.3	887	0.2	272
		115	VAC	230	VAC	100	VAC
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (SO)	383.	469	394	.547	382	.492
	Windows Busy Typ(SO)	1748	.120	1672	2.443	1797	7.800
	Windows Busy Max (SO)	2383	.446	2297	7.863	2410).445
	Sleep (S3)	48.478	47.198	50.150	49.430	51.781	47.379
	Off (S5)	11.980	11.662	12.198	12.181	11.973	11.642
	Zero Power Mode (ErP)	0.9	79	1.3	321	0.9	28

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

System Configuration	Processor Info	Intel [®] Xeon [®] Gold 6130 processor 2.1GHz 12C CPU
Graphics Info 1-NVIDIA® Quadro® P400 2GB		24GB (3x8GB) DDR4-2666 ECC Memory RDIMMs
		1-NVIDIA [®] Quadro [®] P400 2GB
		1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer
	Power Supply	1000 W

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.3	15
	Hard drive Operating (random reads)	3.5	18

System Configuration	Processor Info	Intel [®] Xeon [®] Platinum 8168 processor 2.7GHz 24C CPU
(Mid-range) Memory Info 960		96GB (6x16GB) DDR4-2666 ECC Memory RDIMMs
	Graphics Info	1-NVIDIA [®] Quadro [®] P6000 24GB
	Disks/Optical	2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer
	Power Supply	1000 W

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.8	23
	Hard drive Operating (random reads)	3.9	23



System Technical Specifications

System Configuration	Processor Info	2-Intel [®] Xeon [®] Gold 6136 processor 3.0GHz 12C CPU
(High end)	Memory Info	192GB (12x16GB) DDR4-2666 ECC Memory RDIMMs
	Graphics Info	1-NVIDIA [®] Quadro [®] P6000 24GB
	Disks/Optical	2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer
	Power Supply	1000 W

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)	
	Idle	3.8	23	
	Hard drive Operating (random reads)	3.9	24	

ENVIRONMENTAL DATA

Environmental Requirements	Temperature	Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F)
	Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
	Maximum Altitude	Operating: 3,048 m (10,000 feet)
		Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation
		Non-operating: 9,144 m (30,000 feet)
	Shock (non-repetitive)	Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g
		Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

Access Panel	Tool-less Includes system board and memory information.
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less
	Optional 5.25" external bay carriers
Expansion Cards	Tool-less
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.
Blue User Touch Points	Yes, on primary serviceable components.
Color-coordinated Cables and Connectors	Yes



Memory	Tool-less
System Board	Torx T15 screws
	2nd CPU/Memory Module: Tool-less
Front of Computer LEDs	Dual Color Power/Failure LED = Yes
-	HDD Activity LED = Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image; can be obtained via HP Support.
Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.
Padlock Support	Yes
Cable Lock Support	Kensington Cable Lock (optional): Prevents entire system theft and system access. 3mm x 7mm slot at rear of system
Universal Chassis Clamp Lock Support	Νο
Solenoid Lock and Hood	Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry.
Sensor	Access Panel Intrusion Sensor: Yes (optional).
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes
NIC LEDs (integrated)	Yes
(Green & Amber)	
CPUs and Heatsinks Power Supply Diagnostic	CPU heatsink removal requires a T-30 Torx screwdriver.
LED	
Front Power Button	Yes
Rear Power Button	Yes
Front Power LED	Yes, white (normal), red (fault)
Front Hard Drive Activity LED	Yes, white
Front ODD Activity LED	Yes on device
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
Cooling Solutions	Air cooled forced convection
Power Supply Fans	1 - 80 mm x 80 mm x 25 mm (non-serviceable)
CPU Heatsink Fan	1st CPU: 1 - 80mm
Memory Fan	Optional 2nd CPU: 1 - 60mm x 25mm Front memory fan: 1 – 80mm x 25mm
	Memory duct blower: 1 – 90mm x 25mm 2nd CPU/Memory Module: 1 – 60mm x 25mm



Chassis Fans	Front chassis fan : 1 - 120mm x 25mm Rear chassis fan: 1 - 120mm x 25mm
HP Vision Diagnostics Offline Edition	HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available as a download from HP Support.
Access Panel Key Lock ACPI-Ready Hardware	Yes, side panel barrel keylock (optional from the factory only) Advanced Configuration and Power Management Interface (ACPI).
	 Allows the system to wake from a low-power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system
Trusted Platform Module Chip	Integrated Infineon TPM 2.0. TCG and FIPS 140-2 Certified
Integrated Chassis Handles	Yes, Front handle and dedicated rear recess
Power Supply	Requires T15 Torx or flat blade screwdriver
PCIe Card Retention	Yes, tool-less
	Rear (all)
	Middle (full-height cards) Front (full-length cards with extender)
Flash ROM	Yes
Diagnostic Power Switch	
LED on board	
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes
BIOS	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
АТАРІ	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer	Review and customize system configuration settings controlled by the BIOS.
Setup Utility (F10) System/Emergency ROM	Recovers system BIOS in corrupted Flash ROM.
Flash Recovery with Video	
Replicated Setup	Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.8, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.



Thermal Alert	Monitors the temperature state within the chassis. Three modes:
	NORMAL - normal temperature ranges.
	• ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.
	• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer
	without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.
ACPI (Advanced	Allows the system to enter and resume from low power modes (sleep states).
Configuration and Power	Enables an operating system to control system power consumption based on the dynamic workload.
Management Interface)	Makes it possible to place individual cards and peripherals in a low-power or powered-off state without
	affecting other elements of the system.
Oursership To a	Supports ACPI 5.0 for full compatibility with 64-bit operating systems.
Ownership Tag Domoto Wakeya (Domoto	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
Instantly Available PC	Allows for very low power consumption with quick resume time.
(Suspend to RAM - ACPI	
sleep state S3)	
Remote System	Allows a new or existing system to boot over the network and download software, including the
Installation via F12 (PXE	operating system.
2.1) (Remote Boot from	
Server) ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is
	available through an industry standard interface (SMBIOS and WMI) so that management SW
	applications can use and report this information.
System board revision	Allows management SW to read revision level of the system board.
level	Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics	Assesses system health at boot time with selectable levels of testing.
(Power-on Self-Test)	
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with
Localizea Nori Secup	local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Industry Standard	
Specification Support	
Industry Standard	Revision Supported by the BIOS
UEFI Specification	2.5
Revision	
	Advanced Configuration and Power Management Interface, Version 5.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	PCI Local Bus Specification, Revision 2.3
	PCI Power Management Specification, Revision 1.1
	PCI Firmware Specification, Revision 3.0, Draft .7



System Technical Specifications

PCI Express	PCI Express Base Specification, Revision 2.0
	PCI Express Base Specification, Revision 3.0
РММ	POST Memory Manager Specification, Version 1.01
SATA	Serial ATA Specification, Revision 1.0a
	Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5
	Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
ТРМ	Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)
	Common Criteria EAL4+ Certified
	FIPS 140-2 Certification
	TCG TPM Certified products list:
	http://www.trustedcomputinggroup.org/certification/tpm-certified-products/
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification
	Universal Serial Bus Revision 2.0 Specification
	Universal Serial Bus Revision 3.1 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.8
	External BIOS simulator found at: http://csrsml.itcs.hp.com/

Social and Environmental Responsibility

Eco-Label Certifications & Declarations	& This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:
	 ENERGY STAR[®] (energy-saving features available on selected configurations-Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program The ECO declaration (TED)
Batteries	The Z6 G4 is registered EPEAT® Gold in the US and Canada. EPEAT® registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3 rd party option store for solar generator accessories at http://www.hp.com/go/options The battery in this product complies with EU Directive 2006/66/EC Battery mass: 3g Battery type: Lithium Metal
	The battery in this product does not contain:
	 Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight
Restricted Material Usage	e This product meets the material restrictions specified in HP's General Specification for the Environment
	HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis
Low Halogen Statement	This product is low-halogen except for power cords, external cables and peripherals. Service parts



obtained after purchase may not be low-halogen.

End-of-Life Management and Recycling HP Inc. Corporate Environmental Information	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life. For more information about HP's commitment to the environment: Sustainability Report
	Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html
Additional Information	ISO 14001 certificate: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Product Disassembly Instructions
	 Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
Packaging	HP Workstation product packaging meets the HP's General Specification for the Environment
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of
	 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is recyclable All packaging material is designed for ease of disassembly Reduced size and weight of packages to improve transportation fuel efficiency
	 Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting A multi-unit eco packaging option is available to institutional customers that uses less packaging material or has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details.
Packaging Materials Internal External	Cushions and plastic bags made of low density polyethylene (LDPE). Outer carton, accessories carton, and insert made of corrugated paper board.
Manageability Industry Standard Specifications	 This product meets the following industry standard specifications for manageability functionality: DASH 1.1 (via Intel[®] LAN on motherboard)
Intel® Active Management Intel® Active Management Technology (AMT) 11.2x Technology (AMT)	
	An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.2x includes the following advanced management functions: • Power Management (on, off, reset, graceful shutdown, sleep and hibernate) • Support in Max Power Savings (Shutdown and Hibernate Modes) • Hardware Inventory (includes BIOS and firmware revisions) • Hardware Alerting



System Technical Specifications

	 Agent Presence System Defense Filters Serial Over LAN (SOL) USB Redirect (Media Redirection) ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled DASH 1.1 compliance IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support Host Base set-up and configuration Management Engine (ME) firmware roll back Local Time Sync to UTC
Intel® vPro™ Technology	 Remote Memory Dump Command – Creates memory dump for debug The HP Z6 G4 Workstation supports Intel[®] vPro[™] technology when configured as outlined below:
	 Intel[®] Xeon[®] processor Scalable Family Intel[®] C622 chipset Intel[®] I219LM GbE LAN
Remote Manageability Software Solutions	The HP Z6 G4 Workstation is supported on the following remote manageability software consoles:
	 LANDesk Management Suite (HP recommended solution) Microsoft System Center Configuration Manager HP Client Automation Enterprise
	For questions or support for manageability needs, please visit http://www.hp.com/go/clientmanagement
System Software Manager	For questions or support for SSM, please visit: http://www.hp.com/go/ssm
Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on- site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.
	 NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.



System Technical Specifications

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

Global Series SKUs	this breakthrough platf Consistent Offerings are designed and tested to	ent to hardware, software, and solution innovation, HP is proud to introduce orm configuration stability to HP Workstation customers. HP Stable & e built on the foundation of a carefully chosen set of hardware and software work with all HP Z Workstation platforms through their end of life. These orresponding HP Workstation platform compatibility are outlined in this		
Stable & Consistent Offerings	HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.			
Processors	Product #	Offering		
	2DL32AV	Intel [®] Xeon [®] Gold 6128 processor		
	2DL32AV, 1XM44AA	Intel [®] Xeon [®] Gold 6128 2 nd processor		
	2DL22AV	Intel [®] Xeon [®] Silver 4114 processor		
	2DL22AV, 1XM49AA	Intel [®] Xeon [®] Silver 4114 2nd processor		
	2DL18AV	Intel® Xeon® Silver 4108 processor		
	2DL18AV, 1XM51AA	Intel [®] Xeon [®] Silver 4108 2 nd processor		
Hard Drives	Product #	Offering		
	Z5H22AV, LQ037AA	1TB SATA 7200 RPM 3.5" HDD		
Graphics	Product #	Offering		
	2TF08AA	AMD Radeon™ Pro WX 3100 4GB Graphics		
Memory	Product #	Offering		
	TBD	TBD		
Optical and Removable	Product #	Offering		
Storage	TBD	TBD		



Technical Specifications - Processors

Intel[®] Xeon[®] W-3200 Series CPU

Intel[®] Xeon[®] W-3245 3.2 2933 16C processor Intel® Xeon® W-3235 3.3 2933 12C processor Intel® Xeon® W-3225 3.7 2666 8C processor Intel® Xeon® W-3223 3.5 2666 8C processor Intel[®] Xeon[®] Scalable CPU Intel[®] Xeon[®] Platinum 8280 processor Intel[®] Xeon[®] Platinum 8260 processor Intel[®] Xeon[®] Platinum 8180 processor Intel[®] Xeon[®] Platinum 8160 processor Intel[®] Xeon[®] Gold 6258R processor Intel[®] Xeon[®] Gold 6254 processor Intel[®] Xeon[®] Gold 6252 processor Intel[®] Xeon[®] Gold 6248R processor Intel[®] Xeon[®] Gold 6248 processor Intel[®] Xeon[®] Gold 6246R processor Intel[®] Xeon[®] Gold 6244 processor Intel[®] Xeon[®] Gold 6242R processor Intel[®] Xeon[®] Gold 6242 processor Intel[®] Xeon[®] Gold 6240R processor Intel[®] Xeon[®] Gold 6240Y processor Intel[®] Xeon[®] Gold 6240 processor Intel[®] Xeon[®] Gold 6238R processor Intel[®] Xeon[®] Gold 6230R processor Intel[®] Xeon[®] Gold 6230 processor Intel[®] Xeon[®] Gold 6226R processor Intel[®] Xeon[®] Gold 6226 processor Intel[®] Xeon[®] Gold 6152 processor Intel[®] Xeon[®] Gold 6154 processor Intel[®] Xeon[®] Gold 6148 processor Intel[®] Xeon[®] Gold 6146 processor Intel[®] Xeon[®] Gold 6144 processor Intel[®] Xeon[®] Gold 6142 processor Intel[®] Xeon[®] Gold 6140 processor Intel® Xeon® Gold 6138 processor Intel[®] Xeon[®] Gold 6136 processor Intel[®] Xeon[®] Gold 6134 processor Intel[®] Xeon[®] Gold 6132 processor Intel[®] Xeon[®] Gold 6130 processor Intel[®] Xeon[®] Gold 6128 processor Intel[®] Xeon[®] Gold 5222 processor Intel[®] Xeon[®] Gold 5220R processor Intel[®] Xeon[®] Gold 5220 processor Intel[®] Xeon[®] Gold 5218R processor



Technical Specifications - Processors

Intel[®] Xeon[®] Gold 5218 processor Intel[®] Xeon[®] Gold 5215 processor Intel[®] Xeon[®] Gold 5120 processor Intel[®] Xeon[®] Gold 5118 processor Intel[®] Xeon[®] Gold 5115 processor Intel[®] Xeon[®] Gold 5122 processor Intel[®] Xeon[®] Gold 4216 processor Intel[®] Xeon[®] Gold 4215 processor Intel[®] Xeon[®] Gold 4214R processor Intel[®] Xeon[®] Gold 4214Y processor Intel[®] Xeon[®] Gold 4214 processor Intel[®] Xeon[®] Gold 4210R processor Intel[®] Xeon[®] Gold 4210 processor Intel[®] Xeon[®] Gold 4208 processor Intel[®] Xeon[®] Silver 4116 processor Intel[®] Xeon[®] Silver 4114 processor Intel[®] Xeon[®] Silver 4112 processor Intel[®] Xeon[®] Silver 4110 processor Intel[®] Xeon[®] Silver 4108 processor Intel[®] Xeon[®] Bronze 3206R processor Intel[®] Xeon[®] Gold 3204 processor Intel[®] Xeon[®] Bronze 3106 processor Intel[®] Xeon[®] Bronze 3104 processor



STORAGE/HARD DRIVES

HP SAS (Serial Attached SCSI) Hard Drives for HP	HP 300GB SAS 15K SFF HDD	Capacity Height	300GB 5.9 in; 15 cm	
Workstations		Width	Media Diameter	3.5 in; 8.9 cm
		Interface	12Gb/s SAS	
		Synchronous Transfer Rate (Maximum)	Up to 1200 MB/s (SAS si	ingle port)*
		Buffer	128MB	
		Seek Time (typical reads, includes controller overhead, including settling)	Average	2.0ms *
		Rotational Speed	15K rpm	
		Operating Temperature	41° to 131° F (5° to 55° (C)
		*Actual performance may	/ary.	
	HP 1.2TB SAS 15K SFF HDD	Capacity	1.2TB	
		Height	0.6 in; 1.53 cm	
		Width	Media Diameter	2.5 in; 6.36 cm
			Physical Size	2.75 in; 6.99 cm
		Interface	SAS 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
		Buffer	64MB	
		Seek Time (typical reads,	Single Track	0.18ms (max)*
		includes controller	Average	3.5ms*
		overhead, including settling)	Full Stroke	7.17ms*
		*Actual performance may	vary.	



SATA (Serial ATA) Hard	500GB SATA 7200 rpm	Capacity	500GB	
Drives for HP	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
Workstations		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), N	CQ enabled
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
		Buffer	16MB	
		Seek Time (typical reads,	Single Track	2 ms*
		includes controller overhead, including settling)	Average Full Stroke	11 ms* 21 ms*
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating Temperature	41° to 131° F (5° to 55°	C)
		*Actual performance may	-	2,
		needat performance may		
	1TB SATA 7200 rpm	Capacity	1TB	
	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), N	CQ enabled
		Synchronous Transfer Rate (Maximum)	Up to 600 MB/s*	
		Buffer	64MB	
		Cache	Adaptive	
		Seek Time (typical reads,	Single Track	2 ms*
		includes controller overhead, including	Average	11 ms*
		settling)	Full Stroke	21 ms*
		Rotational Speed	7,200 rpm	
		Operating Temperature	41° to 131° F (5° to 55°	C)
		*Actual performance may	vary.	
		a b		
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD CMR	Capacity	2.0TB	
		Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
		Interface	Physical Size Serial ATA (6.0 Gb/s), N	4 in; 10.17 cm
		Synchronous Transfer	Up to 600 MB/s*	
		Rate (Maximum)		
		Buffer	64MB	
		Seek Time (typical reads,	Single Track	1.0 ms*
		includes controller overhead, including	Average	11 ms*
		settling)	Full Stroke	18 ms*
		Rotational Speed	7,200 rpm	



HP Z6 G4 Workstation

	Logical Blocks Operating Temperature *Actual performance may		C)
2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR	Capacity Height Width	2.0TB 1 in; 2.54 cm Media Diameter Physical Size	3.5 in; 8.9 cm 4 in; 10.17 cm
	Interface	Serial ATA (6.0 Gb/s), N	
	Synchronous Transfer Rate (Maximum)	Up to 600 MB/s*	
	Buffer	64MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track Average Full Stroke	1.2 ms* 12 ms* 21 ms*
	Rotational Speed	7,200 rpm	
	Logical Blocks	3,907,029,168	
	Operating Temperature	41° to 140° F (5° to 60°	C)
	*Actual performance may	vary.	
3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Capacity Height	3.0TB 1 in; 2.54 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4.0 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), NO	Q enabled
	Synchronous Transfer Rate (Maximum)	Up to 6.0 Gb/s*	
	Buffer	64MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track Average Full Stroke	0.6 ms* 11 ms* Not Specified*
	Rotational Speed	7,200 rpm	
	Operating Temperature	41° to 140° F (5° to 60°	C)
	*Actual performance may	vary.	

1TB SATA 7200 rpm	Capacity	1TB		
6Gb/s 3.5" HDD	Protocol	SATA		
(Enterprise Class)	Form Factor	3.5"		
	Controller	AHCI		
	Reliability (MTBF)	2.0M hours		
	Rated Power On Hours	8760/yr		
	Annualized Failure Rate (based on Rated POH)	<0.62%		
	Rated for 24/7/365 operation	YES		
	Physical Size (Height)	1 in; 2.54 cm		
	Physical Size (Width)	4 in; 10.17 cm		
	Media Diameter	3.5 in; 8.9 cm		
	Interface	Serial ATA (6Gb/s), NCQ	enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*		
	Buffer	128MB		
	Seek Time (typical reads,	Single Track	0.32ms*	
	includes controller	Average	7.45ms*	
	overhead, including settling)	Full Stroke	14.2ms*	
	Operating Temperature	41° to 140° F (5° to 60°	C)	
	Performance	Sequential Read	up to 226MB/s*	
		Sequential Write	up to 226MB/s*	
	Enterprise Class Features	s High Reliability		
	*Actual performance may	varv		

*Actual performance may vary.



4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Capacity Height Width Interface	4TB 0.275 in; 0.7 cm Media Diameter Physical Size Serial ATA (6Gb/s), NCQ	2.5 in; 6.36 cm 2.75 in; 6.99 cm enabled
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Buffer	128MB	
	Seek Time (typical reads,	Single Track	0.7ms*
	includes controller overhead, including	Average	8.5ms*
	settling)	Full Stroke	15.7ms*
	Rotational Speed	7,200 rpm	
	Operating Temperature	32° to 140° F (0° to 60° (])
	*Actual performance may	vary.	
500GB SATA 7.2K SED SFF HDD	Capacity Height	500GB 0.275 in; 0.7 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Buffer	32MB	
	Seek Time (typical reads,	Single Track	1ms*
	includes controller	Average	4.2ms*
	overhead, including settling)	Full Stroke	25ms (typical)*
	Rotational Speed	7,200 rpm	
	Operating Temperature	32° to 140° F (0° to 60° (<u>[</u>)
	*Actual performance may v	vary.	

SATA SSDs for HP	HP 256GB SATA 6Gb/s	Capacity	256GB	
Workstations	SSD	Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	192TBW (TB Written)	
		Reliability (MTTF)	1.5M hours	
		Physical Size (Height)	0.28 in; 0.7 cm	
		Physical Size (Width)	2.5 in; 6.36 cm	
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
		Operating Temperature	32° to 158° F (0° to 70°	° C)
		Performance	Sequential Read	530MB/s (max)*
			Sequential Write	500MB/s (max)*
			Random Read	95K IOPS (max)*
			Random Write	83K IOPS (max)*
		*Actual performance may	vary.	
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	Capacity	256GB	
		Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	192TBW (TB Written)	
		Reliability (MTTF)	1.5M hours	
		Physical Size (Height)	0.28 in; 0.7 cm	
		Physical Size (Width)	2.5 in; 6.36 cm	
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequential Read)*	
		Operating Temperature	32° to 158° F (0° to 70°	' C)
		Performance	Sequential Read	530MB/s*
			Sequential Write	500 MB/s*
			Random Read	95K IOPS*
			Random Write	83K IOPS*
		Self-Encrypting Drive Support	OPAL 2	
		*Actual performance may	vary.	
	HP 512GB SATA 6Gb/s	Capacity	512GB	
	SSD	Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	388TBW (TB Written)	



	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequer	itial Read)*
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s*
		Random Read	95K IOPS*
		Random Write	83K 10PS*
	*Actual performance may v	/ary.	
HP 512GB SATA SED SSD	Capacity	512GB	
	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	388TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s*
		Random Read	95K 10PS*
		Random Write	83K 10PS*
	Self-Encrypting Drive Support	OPAL 1 and 2	
	*Actual performance may v	/ary.	
HP 1TB SATA 6Gb/s SSD	Capacity	1TB	
	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequer	itial Read)*
	Operating Temperature	27º to 159º 5 (0º to 70º	\sim



Operating Temperature 32° to 158° F (0° to 70° C)

	Performance	Sequential Read Sequential Write	530 MB/s* 500 MB/s*
		Random Read	95K IOPS*
		Random Write	83K IOPS*
	*Actual performance may v	ary.	
HP 2TB SATA 6Gb/s SSD	Capacity	2TB	
	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability (MTTF)	1.5M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	SATA 6Gb/s	
	Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequen	tial Read)*
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	530 MB/s*
		Sequential Write	500 MB/s *
		Random Read	95K IOPS*
		Random Write	83K IOPS*
	*Actual performance may v	ary.	
HP Enterprise Class	Capacity	240GB	
240GB SATA SSD	Protocol	SATA	
	Form Factor	2.5"	
	Controller	AHCI	
	NAND Type	3D TLC	
	Endurance	2,200TBW (TB Written)	
	Reliability (MTTF)	2.0M hours	
	Physical Size (Height)	0.28 in; 0.7 cm	
	Physical Size (Width)	2.5 in; 6.36 cm	
	Interface	6Gb/s SATA	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	540 MB/s*
		Sequential Write	310 MB/s*
		Random Read	93K IOPS*
		Random Write	48K IOPS*
	Enterprise Class Features	High Endurance NAND Power Loss Protection End-to-End Data Protect	tion
	*Actual performance may v	ary.	

	HP Enterprise Class	Capacity	480GB	
	480GB SATA SSD	Protocol	SATA	
		Form Factor	2.5"	
		Controller	AHCI	
		NAND Type	3D TLC	
		Endurance	4,400TBW (TB Written)	
		Reliability (MTTF)	2.0M hours	
		Physical Size (Height)	0.28 in; 0.7 cm	
		Physical Size (Width)	2.5 in; 6.36 cm	
		Interface	6Gb/s SATA	
		Synchronous Transfer	Up to 600MB/s*	
		Rate (Maximum)	op to cool 12/0	
		Operating Temperature	32° to 158° F (0° to 70°	C)
		Performance	Sequential Read	540 MB/s*
			Sequential Write	460 MB/s*
			Random Read	93K IOPS*
			Random Write	74K IOPS*
		Enterprise Class Features	High Endurance NAND Power Loss Protection End-to-End Data Prote	ction
		*Actual performance may v	ary.	
Value PCIe SSDs for	HP 256GB M.2 2280 SSD	Capacity	256GB	
HP Workstations		Protocol	PCIe	
		Form Factor	M.2	
		Controller	NVMe	
		NAND Type	TLC	
		Endurance	200TB	
		Reliability (MTBF)	1.5M hours	
		Interface	PCI Express 3.0 x4 elec	trical x4 physical
		Operating Temperature	32° to 158° F (0° to 70°	C)
		Performance	Sequential Read	3100 MB/s *
			Sequential Write	1400 MB/s *
			Random Read	200K IOPS *
			Random Write	320K IOPS *
		*Actual performance may vary.		
	HP 512GB M.2 2280 SSD	Capacity	512GB	
	IIF J I Z UD M.Z Z Z OU J J D	Protocol	PCIe	
		Form Factor	M.2	
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	300TB	
		Reliability (MTBF)	1.5M hours	
		Interface		trical x4 physical
			PCI Express 3.0 x4 electrical x4 physical	

Operating Temperature	32° to 158° F (0° to 70° C)		
Performance	Sequential Read 3400 MB/s*		
	Sequential Write	2500 MB/s*	
	Random Read	380K IOPS*	
	Random Write	430K IOPS*	
*Actual performance may vary.			

HP Z Turbo Drive G2 1TB Capacity 1TB SSD Protocol PCle **Form Factor** M.2 Controller NVMe NAND Type 3D TLC 400TB Endurance Reliability (MTTF) 1.5M hours Interface PCI Express 3.0 x4 electrical x4 physical **Operating Temperature** 32° to 158° F (0° to 70° C) Performance **Sequential Read** 3400 MB/s* **Sequential Write** 2500 MB/s* **Random Read** 500K IOPS* **Random Write** 440K IOPS*

*Actual performance may vary.



Performance PCIe SSDs for HP Workstations	HP Z Turbo Drive Dual Pro 256GB PCIe SSD	Capacity Interface Operating Temperature	256GB (one M.2 PCIe N PCI Express 3.0 x4 elec 32° to 158°F (0° to 70°	ctrical x4 physical
	HP Z Turbo Drive Dual Pro 512GB PCIe SSD	Capacity Interface Operating Temperature	512GB (one M.2 PCIe N PCI Express 3.0 x4 elec 32° to 158°F (0° to 70°	ctrical x4 physical
	HP Z Turbo Drive Dual Pro 1TB PCIe SSD	Capacity Interface Operating Temperature	1TB (one M.2 PCIe NVM PCI Express 3.0 x4 elec 32° to 158°F (0° to 70°	ctrical x4 physical
	HP Z Turbo Drive Dual Pro 2TB PCIe SSD	Capacity Interface Operating Temperature	2TB (one M.2 PCIe NVM PCI Express 3.0 x4 elec 32° to 158°F (0° to 70°	ctrical x4 physical
	HP Z Turbo Drive Quad Pro 2x256GB PCIe SSD	Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTBF) Interface Operating Temperature Performance	512GB PCIe PCIe Card, Full Height I NVMe 3D TLC 200TB 1.5M hours PCIe Gen3 x4 architect 32° to 158° F (0° to 70° Sequential Read Sequential Write Random Read Random Write	ure
	HP Z Turbo Drive Quad Pro 2x512GB PCIe SSD	*Actual performance may Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTBF) Interface Operating Temperature Performance	1TB PCIe PCIe Card, Full Height I NVMe 3D TLC 300TB 1.5M hours PCIe Gen3 x4 architect 32° to 158° F (0° to 70' Sequential Read Sequential Write Random Read	ure



HP 2 Turbo Drive Quad Capacity 2TB Protocol PCle Form Factor PCle Card, Full Height PC ISIO Controller NVMe NAND Type 20 TLC Endurance 400TB Interface 00 El Card, Full Height PC ISIO Operating Temperature 22*to 158° F (0° to 70° - 7000 Performance Sequential Read 3500 MB/s° Random Read 5800 KI0PS* Performance may restrict Sequential Writer 3000 MB/s° Seguential Kead 5800 KI0PS* Sequential Writer Solok KI0PS* *Actual performance may restrict Sequential Writer Solok KI0PS* *SeGB TLC SED Sand Capacity 256GB TLC SED Sand Protocol NMe NAND Type 3D TLC SED Support 0pal 2 Sequential Writer Sequential Writer Endurance 200 Figers 3.0 x4 electrict x4 physical Sequential Writer		*Actual performance may	Random Write vary.	500K IOPS*
Protecol PCIe Form Factor PCIe Card, Full Height PCIe Slot Controller NMMe NAND Type 3D TLC Endurance 400TB Interface PCI Express 3.0 x4 electria x4 physical Operating Temperature 32° to 158° F (0° to 70° C Performance Sequential Read 3000 MB/s* Random Write 500 K IDPS* Random Write 500 K IDPS* Yactual performance may				
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			Sequential Write	2900 MB/s *

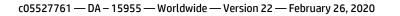


Random Read

460K IOPS*

HP Z6 G4 Workstation

		Random Write	500K 10PS*
	*Actual performance may	vary.	
HP Z Turbo Drive G2	Capacity	1TB	
1TB TLC SSD and	Protocol	PCIe	
1TB TLC SED SSD	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	SED Support	Opal 2	
	Endurance	400TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elect	rical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	3500 MB/s*
		Sequential Write	3000 MB/s *
		Random Read	580K IOPS*
		Random Write	500K IOPS*
	*Actual performance may	vary.	
HP Z Turbo Drive G2	Capacity	2TB	
2TB TLC SSD and	Protocol	PCIe	
2TB TLC SED SSD	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	SED Support	Opal 2	
	Endurance	500TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 3.0 x4 elect	
	Operating Temperature	32° to 158° F (0° to 70°	-
	Performance	Sequential Read	3500 MB/s*
		Sequential Write	3000 MB/s *
		Random Read	600K IOPS*
	Actual parformanco may	Random Write	500K IOPS
	*Actual performance may	-	
HP Z Turbo Drive Quad Pro 256GB SSD module	Capacity	256GB (one M.2 PCIe NV	/Me module)
	Interface	PCI Express 3.0 x4 elect	rical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	
HP Z Turbo Drive Quad Pro 512GB SSD module	Capacity	512GB (one M.2 PCIe NV	/Me module)
	Interface	PCI Express 3.0 x4 elect	rical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	C)
HP Z Turbo Drive Quad Pro 1TB SSD module	Capacity	1TB (one M.2 PCIe NVM	e module)
	Interface	PCI Express 3.0 x4 elect	rical x4 physical
	Operating Temperature	32° to 158° F (0° to 70°	C)





Fechnical Specificat	ions - Hard Drives			
	HP Z Turbo Drive Quad Pro 2TB SSD module	Capacity	2TB (one M.2 PCIe NV	'Me module)
		Interface	PCI Express 3.0 x4 ele	ectrical x4 physical
		Operating Temperature	32° to 158° F (0° to 7	0° C)
Intel® 905p Series AIC	Intel® 905p Series AIC	Capacity	280GB	
PCIe SSD	280GB PCIe SSD	Protocol	PCle	
		Form Factor	PCIe Card, Half Heigh	t
		Controller	NVMe	
		NVM Туре	3DXPoint	
		Endurance	5.11 PBW (PB Writter	ר)
		Reliability (MTBF)	1.6M hours	
		Operating Temperature	32° to 185° F (0° to 8	5° C)
		Performance	Sequential Read	2730 MB/s*
			Sequential Write	2280 MB/s*
			Random Read	587K IOPS*
			Random Write	559K IOPS*
		*Actual performance may	vary.	
Intel® 905p S 480GB PCIe S	Intel [®] 905p Series AIC	Capacity	480GB	
	480GB PCIe SSD	Protocol	PCIe	
		Form Factor	PCIe Card, Half Heigh	t
		Controller	NVMe	
		NVM Туре	3DXPoint	
		Endurance	8.76 PBW (PB Writter	ר)
		Reliability (MTBF)	1.6M hours	
		Operating Temperature	32° to 185° F (0° to 8	5° C)
		Performance	Sequential Read	2710 MB/s*
			Sequential Write	2280 MB/s*
			Random Read	582K IOPS*
		Actual performance may	Random Write vary.	561K IOPS
Intel® Optane™ DC Persistent Memory	Intel® Optane™ DC Persistent Memory	Capacity	128GB	
i ci sistent richiui y	128GB Module	Protocol	DDR-T	
		Form Factor	DDR4	
		Controller	NVMe	
		NVM Type Endurance	3DXPoint 292 PBW (256B Sequent 21 DBW (64B Sequent	
		Reliability (MTBF)	91 PBW (64B Sequen 2M hours	
		NCUADILILY (MIDE)		
		Operating Temperature	32° to 185° F (0° to 8	5° ()



Sequential Write 1850 MB/s*

*Actual performance may vary.



Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

Microsemi SmartHBA2100-4i4e SAS Controller	PCI Bus	8 lanes, PCI Express 3.0	
	RAID Levels	Offers Integrated RAID (0, 1, and 10)	
	PCI Data Burst Transfer Rate	Half Duplex x8, PCIe, 8000 MB/s	
	SAS Bandwidth	Half Duplex	1200 MB/s per lane
	PCI Card Type	3.3V Add-in Card	
	PCI Voltage	12 V ± 10%	
	PCI Power	9.8W typical, Airflow min 200 LFM	
	Bracket	Full height and low profile	
	Certification Level	PCI Express 3.0 compliant	
	SAS Processor	Microsemi SmartIOC 2100 SAS IO Cont	troller
	Internal Connectors	One x4 internal mini-SASHD (SFF-864	43)
	External Connectors	One x4 external mini-SASHD (SFF-864	14)
	Maximum Number of SCSI Devices	256 Non-RAID SAS/SATA devices	
	LED Indicators	Connector for Drive Activity Light	

Technical Specifications - Graphics

GRAPHICS

NVIDIA® Quadro® P400 2GB Graphics	Form Factor	Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P400 Graphics Card GPU: 256 NVIDIA® CUDA® cores Max Power: 30 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s
	Connectors	3mDP Outputs
	Maximum Resolution	DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	3 mDP Connectors
	Shading Architecture	Full Microsoft DirectX [®] 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL [®] 4.5 DirectX [®] 12 Vulkan™ 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL™
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 7 Professional 64-bit Linux®
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	
NVIDIA® Quadro® P620 2GB Graphics	Form Factor	Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P620 Graphics Card GPU: 512 CUDA cores Max Power: 40 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 2 GB GDDR5, 2000 MHz Memory Interface: 128-bit Memory Bandwidth: 64 GB/s



	Connectors	4mDP Outputs *
	Maximum Resolution	DisplayPort™ 1.4:
		- up to 4x 5120 x 2880 x 24 bpp @ 60Hz
		- supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	4 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes:
		CUDA C, CUDA C++, DirectCompute , OpenCL
	Available Graphics Drivers	Windows10 (64-bit) Windows 7 Professional 64-bit
	DIIVEIS	
		Linux®
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	*P620 only have mini-DisplayPort™ (mDP) video ports.
		Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit:Two mDP-to-DP Adapters included
		Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: - 2MY05AA - HP miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
AMD FirePro™ W2100 2GB Graphics	Form Factor	Low Profile, half length (full-height bracket included)
2 ου σταμπες	Graphics Controller	AMD FirePro™ W2100 professional graphics based on Oland GPU. GPU: 320 Stream Processors organized into 5 Compute Units GPU Frequency: 630Mhz Power: 26W Cooling: Active
	Bus Type	PCI Express [®] x8, Generation 3.0
	Memory	2GB DDR3 memory Memory Bandwidth: up to 28.8 GB/s Memory Width: 128 bit
	Connectors	2x Display Port™ 1.2 connectors
		Factory Configured: No video cable adapter included After market option kit: No video cable adapter included



		Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	DisplayPort™ 1.2: - up to 4096x2160 x 24 bpp @ 60Hz
		Dual Link DVI(I) (requires adapter cable): - up to 2560 x 1600 x 32 bpp @ 60Hz
		Single Link-DVI(I)(requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz
		VGA (requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling.
	Display Output	2 x DisplayPort™ 1.2a Maximum number of displays: 2
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	OpenCL™ 1.2, DirectX [®] 11.2/12, OpenGL [®] 4.4
		OpenGL [®] 4.4 support with driver release 14.301.xxx OpenCL™ 1.2 conformance expected with drive release 14.301.xxx
	Available Graphics Drivers	Windows10 (64-bit) Windows 7 Professional 64-bit Linux®
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	Depending on the card model, native DisplayPort [™] connectors and/or certified DisplayPort [™] active or passive adapters to convert your monitor's native input to your card's DisplayPort [™] or Mini-DisplayPort [™] connector(s) may be required. See www.amd.com/FirePro [™] for details.
NVIDIA® Quadro® P1000 4GB Graphics	Form Factor	Dimensions:2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P1000 Graphics Card GPU: 640 NVIDIA® CUDA® cores
	Pue Tupe	Max Power: 47 Watts
	Bus Type Momory	PCI Express 3.0 x16
	Memory	Size: 4 GB GDDR5, 2500 MHz Memory Interface: 128-bit memory interface



		Memory Bandwidth: 80 GB/s memory bandwidth
	Connectors	4mDP Outputs
	Maximum Resolution	DisplayPort™ 1.4:
	Maximum Resolution	- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	4 mDP Connectors
	Shading Architecture	Full Microsoft DirectX [®] 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL [®] 4.5 DirectX [®] 12 Vulkan™ 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL™
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 7 Professional 64-bit Linux®
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	
NVIDIA® Quadro® P2000 5GB Graphics	Form Factor	Dimensions: 4.4"Hx7.9"L Single Slot Cooling: Active Weight: 260 grams
	Graphics Controller	NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s Memory Width: 160-bit
	Connectors	4x DisplayPort™ 1.4
		Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included
		Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready.
		DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz
		Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz



		HDMI 2.0 (requires DP to HDMI adapter):
		5120 x 2880 x 24 bpp @ 60Hz
	Image Quality Features	12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection)
		Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView.
	Display Output	Maximum number of displays - 4 direct attached monitors
		Maximum number of monitors across all available Quadro P2000 outputs is 4.
	Shading Architecture	Shader Model 5.1
	Supported Graphics APIs	OpenGL [®] 4.5
		DirectX [®] 12
		API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software
	Available Graphics	Microsoft Windows 10
	Drivers	Microsoft Windows 7 Professional 64bit Linux [®] - Full OpenGL [®] implementation, complete with NVIDIA [®] and ARB extensions
		HP qualified drivers may be preloaded or available from the HP support
		Web site:
	Notes	http://welcome.hp.com/country/us/en/support.html
NVIDIA® Quadro® P2200 5GB Graphics	Form Factor	Dimensions: 4.4"H x 7.9"L Single Slot, Full Height
·		Weight: 260 grams
	Graphics Controller	
•	Graphics Controller	Weight: 260 grams NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores
•	Graphics Controller	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts
	Graphics Controller	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores
	Graphics Controller Bus Type	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts
		NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X
	Bus Type	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s
	Bus Type	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X
	Bus Type Memory	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit
	Bus Type Memory	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit 4x DisplayPort™ 1.4 Factory Configured Option: No adapter included with card
	Bus Type Memory	NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active PCI Express 3.0 x16 Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit 4x DisplayPort™ 1.4 Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and



		- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready.
		DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz
		Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz
		HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz
	Image Quality Features	12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection)
		Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView.
	Display Output	Maximum number of displays - 4 direct attached monitors
		Maximum number of monitors across all available NVIDIA® Quadro® P2200 outputs is 4.
	Shading Architecture	Shader Model 5.1
	Supported Graphics APIs	OpenGL [®] 4.5 DirectX [®] 12
		API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux® - Full OpenGL [®] implementation, complete with NVIDIA® Quadro [®] and ARB extensions
		HP qualified drivers may be preloaded or available from the HP support Web site:
	Notes	 http://welcome.hp.com/country/us/en/support.html Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. Quadro P2200 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.
AMD Radeon™ Pro WX	Form Factor	Low-Profile Single Slot (6.6" Length)
3100 4GB Graphics	Graphics Controller	Polaris12 GL GPU: 512 Stream Processors organized into 8 Compute Units Power: 50 Watts Cooling: Active
	Memory	4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit



	Connectors	2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
		Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included
		Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 3x 4K support @ 60Hz
	Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	3 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
	GPU Architecture	Polaris
	Supported Graphics APIs	DirectX°12 OpenGL° 4.5 OpenCL™ 2.0 Vulkan™ 1.0
	Available Graphics Drivers	Windows 10 64-bit (Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
AMD Radeon™ Pro WX 3200 4GB Graphics	Form Factor Graphics Controller	Low-Profile Single Slot (2.75 "H x 6.6" L) Radeon™ Pro WX 3200 Graphics Card GPU: 640 Stream Processors organized into 8 Compute Units



Memory	Power: 56 Watts Cooling: Active 4GB GDDR5 memory Memory Bandwidth: 96 GB/s Memory Width: 128 bit	
Connectors	4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.	
	Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included	
	Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.	
Maximum Resolution	5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz	
Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling	
Display Output	4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support	
GPU Architecture	Polaris	
Supported Graphics APIs	DirectX°12 OpenGL° 4.6 OpenCL™ 2.0 Vulkan™ 1.0	
Available Graphics Drivers	Windows 10 64-bit Linux® 64-bit (selected Enterprise distributions)	
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 	



Radeon™ Pro WX 4100	Form Factor	Low-Profile Single Slot (6.6" Length)
4GB Graphics	Graphics Controller	Polaris 11 Baffin GL XT
		GPU: 1024 Stream Processors organized into 16 Compute Units
		Power: 50 Watts Cooling: Active
	Memory	4GB GDDR5 memory
	Hemory	Memory Bandwidth: 6 Gbps / 96 GB/s
		Memory Width: 128 bit
	Connectors	4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
		Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included
		Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	5K support @ 60Hz
		• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz
	Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
	GPU Architecture	GCN 4th Generation
	Supported Graphics APIs	
		OpenGL [®] 4.5
		OpenCL™ 2.0 Vulkan™ 1.0
	Ausilable Craphice	Windows 10 64-bit
	Available Graphics Drivers	Windows 10 64-bit Windows [®] 7 64-bit
		Linux [®] 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support
		Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating current curport
		 Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption
		in response to certain GPU load conditions. 9. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent



		verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support.
NVIDIA® Quadro® P4000 8GB Graphics	Form Factor	Dimensions: 4.4"H x 9.5"L Single-slot, full-height Weight: 475 grams (without extender)
	Graphics Controller	NVIDIA® Quadro® P4000 Graphics Card GPU: 1792 CUDA cores Power: 120 Watts
	Bus Type Memory	PCI Express 3.0 x16 Size: 8GB GDDR5 Memory Bandwidth: 243 GB/s Memory Width: 256-bit
	Connectors	4 x DisplayPort 1.4 3-pin mini-DIN connector via optional bracket 1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II 2 x SLI connectors
		Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to- DVI adapters are available as accessories
	Maximum Resolution	Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz
		Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz HDMI™ 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz
		DisplayPort: - up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)
	Image Quality Features	Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution. Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView



Display Output	Maximum number of displays - 4 direct attached monitors	
Shading Architecture Supported Graphics APIs	Maximum number of monitors across all available Quadro P4000 outputs is 4. Shader Model 5.1 GopenGL 4.5 DirectX 12 Vulcan 1.0	
Available Graphics Drivers	API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran Microsoft Windows 10 Microsoft Windows 7 Linux - Full OpenGL implementation, complete with NVIDIA and ARB extensions	
Notes	 HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately. 	

NVIDIA® Quadro® GP100 16GB Graphics	Form Factor Graphics Controller	Dual Slot (4.4" Height x 10.5" Length) Weight: 989 grams +72 grams extender NVIDIA® QUADRO® GP100 GPU: 3584 NVIDIA CUDA® Parallel Processing Cores Power: 235 Watts Cooling: Active
	Memory	16GB HBM2 Memory Bandwidth: Up to 717 GB/s Memory Width: 4096-bit ECC Memory (disabled by default)
	Connectors	DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink connectors

Factory configured option: 8-pin power adapter included with card.



Technical Specifications - Graphics After market option Kit: 8-pin power adapter included with card. DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories. Maximum Resolution 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors **Image Quality Features** HDR support over DisplayPort[™] 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort[™], DVI, and HDMI connectors NVIDIA 3D Vision[™] technology NVIDIA Mosaic and nView Desktop Management **Display Outputs** 4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz) 1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz) HDMI[™] 2.0b (up to 5120 x 2880 @ 60Hz)* *requires DP to HDMI adapter **GPU** Architecture NVIDIA Pascal[™] DirectX[®]12, OpenGL[®] 4.5, Vulkan[™] 1.0 **Supported Graphics** APIs Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran **Available Graphics** Windows[®] 10 Drivers Windows® 7 Professional 64-bit Linux® HP gualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit: No adapters included

NVIDIA® Quadro® P5000 16GB Graphics

Form Factor

Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 815 grams / 1.80 lbs



Graphics Controller	Quadro™ P5000 graphics GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores Power: 180 Watts Cooling: Active
Memory	16GB GDDR5X memory Memory Bandwidth: Up to 288 GB/s Memory Width: 256 bit ECC Memory (disabled by default)
Connectors	DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector SLI connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort [™] to VGA, DisplayPort [™] to DVI, and DisplayPort [™] to Dual-Link DVI adapters available as accessories.
Maximum Resolution	5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors
Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView Desktop Management
Display Outputs ¹	4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz)
GPU Architecture	NVIDIA® Pascal™
Supported Graphics APIs	DirectX®12 , OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran



Technical Specifications - Graphics Windows® 10 64-bit **Available Graphics** Windows[®] 7 64-bit Drivers Linux[®] 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays Notes **NVIDIA®** Quadro® **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 967 grams / 2.14 lbs P6000 24GB Graphics **Graphics Controller** NVIDIA[®] Quadro[®] P6000 graphics GPU: 3840 NVIDIA[®] CUDA[®] Parallel Processing Cores Power: 250 Watts **Cooling:** Active 24GB GDDR5X memory Memory Memory Bandwidth: Up to 432 GB/s Memory Width: 384 bit ECC Memory (disabled by default) Connectors DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector **SLI** connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories. **Maximum Resolution** 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort[™], DVI, and HDMI connectors NVIDIA[®] 3D Vision[™] and other 3D stereo technologies



Technical Specifications - Graphics			
		NVIDIA® Mosaic and nView	
	Display Outputs ¹	4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz)	
	GPU Architecture	NVIDIA® Pascal™	
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran	
	Available Graphics Drivers	Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit	
		HP qualified drivers may be preloaded or available from the HP support Web site:	
	Notes	http://welcome.hp.com/country/us/en/support.html1- Supports up to a total of 4 displays	
NVIDIA® Quadro® RTX 4000 8GB Graphics	Form Factor	Full-Height Single Slot (4.4" Height x 9.5" Length) Weight: 550 grams / 1.21 lbs	
	Graphics Controller	NVIDIA® Quadro® RTX 4000 Graphics GPU: 2304 NVIDIA® CUDA® Parallel Processing Cores Power: 160 Watts Cooling: Active	
	Memory	8GB GDDR6 memory Memory Bandwidth: Up to 416 GB/s Memory Width: 384 bit	
	Connectors	3x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector	
		Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.	
		DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.	



Technical Specifications - Graphics		
	Maximum Resolution	7680x4320 @ 60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView
	Display Outputs ¹	3x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)
	Supported Graphics APIs	DirectX [®] 12, OpenGL [®] 4.5, OpenCL [™] 1.0, Vulkan [™] 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL [™] , Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	1- Supports up to a total of 4 displays
NVIDIA® Quadro® RTX 5000 16GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1050 grams / 2.31 lbs
	Graphics Controller	NVIDIA® Quadro® RTX 5000 Graphics GPU: 3072 NVIDIA® CUDA® Parallel Processing Cores Power: 265 Watts Cooling: Active
	Memory	16GB GDDR6 memory Memory Bandwidth: Up to 448 GB/s Memory Width: 384 bit
	Connectors	4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector
		Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.
		DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.



	Maximum Resolution	7680x4320 @ 60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView
	Display Outputs ¹	4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	1- Supports up to a total of 4 displays
NVIDIA® Quadro® RTX 6000 24GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs
	Graphics Controller	NVIDIA® Quadro® RTX 6000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active
	Memory	24GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit



	Connectors	4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector
		Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.
		DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	7680x4320 @ 60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.
		HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors
		NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView
	Display Outputs ¹	4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site:
	Notos	http://welcome.hp.com/country/us/en/support.html
	Notes	1- Supports up to a total of 4 displays
NVIDIA® Quadro® RTX 8000 48GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs
	Graphics Controller	NVIDIA® Quadro® RTX 8000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active
	Memory	48GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit



	Connectors	4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector
		Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.
		DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	7680x4320 @ 60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView
	Display Outputs ¹	4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Linux® 64-bit
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
	Notes	 Supports up to a total of 4 displays VirtualLink's USB-C[™] (data) cannot be disabled at a hardware level
Radeon™ Pro WX 7100	Form Factor	Full-Height Single Slot (9.5" Length)
8GB Graphics	Graphics Controller	Radeon™ Pro WX 7100 graphics GPU: 2304 Stream Processors organized into 36 Compute Units Power: 130 Watts Cooling: Active
	Memory	8GB GDDR5 memory Memory Bandwidth: 7 Gbps / 224 GB/s Memory Width: 256 bit
	Connectors	4x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
		Factory Configured: No video cable adapter included After market option kit: No video cable adapter included



	Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
Maximum Resolution	5K support @ 60Hz
	• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors
Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
Display Output	4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
GPU Architecture	GCN 4th Generation
Supported Graphics APIs	DirectX [®] 12 OpenGL [®] 4.5 OpenCL™ 2.0 Vulkan™ 1.0
Available Graphics Drivers	Windows 10 64-bit Windows® 7 64-bit Linux® 64-bit
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
Notes	 10. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 11. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice. 12. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. 13. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.



AMD Radeon™ Pro WX 9100 16GB Graphics	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1100 grams / 2.42 lbs
	Graphics Controller	AMD Radeon™ Pro WX 9100 Vega architecture GPU GPU: 4096 NVIDIA® CUDA® Parallel Processing Cores Power: 250 Watts Cooling: Active
	Memory	16GB HBM2 memory Memory Bandwidth: Up to 483 GB/s Memory Width: 384 bit
	Connectors	6x mDP 1.4 Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector
		Factory configured option: No video cable adapter included with card. After market option Kit: 2x mini-DP to DP.
		DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	7680 × 4320 resolution @ 60Hz 6x DP 1.3 4K @60Hz or 3x 5K @60Hz or 1x 8K @60Hz
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA [®] 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView
	Display Outputs ¹	6x mDP 1.4 (7680x4320 @ 60Hz)
	Supported Graphics APIs	DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran
	Available Graphics Drivers	Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit



		HP qualified drivers may be preloaded or available from the HP support Web site:
		http://welcome.hp.com/country/us/en/support.html
	Notes	1- Supports up to a total of 6 displays
NVIDIA® Quadro® Sync II	Part number	1WT20AA
	Dimensions (HxD)	6.0 inches × 4.2 inches
	Devices Supported	NVIDIA® Quadro® P4000 NVIDIA® Quadro® P5000 NVIDIA® Quadro® P6000
	Bus Type	Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector
	PCI Form Factor	Full Height, half length, single slot
	Ports	2 RJ45 connectors for carrying frame lock signals over CAT5 cables. BNC Connector for external house synchronization.
	Internal Connectors	 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's
	System Requirements	Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards. Requires Quadro driver version R375 or later.
	Temperature - Operating	0° to 55° C
	Temperature - Storage	-40° to 60° C
	Relative Humidity - Operating	10% to 80%
	Power Requirements	Board power dissipation: <15W
	Operating Systems Supported	Windows 10 64-bit Windows 7 64-bit Linux® 64-bit
	Kit Contents	Contains: • Quadro Sync II Card • 4 x 12-Inch Short Sync Cables • 2 x 24-Inch Long Sync Cables (Two) • Quick Start Guide

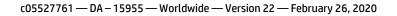


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Technical Specifications – Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim DVD Writer	Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types	9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
		Full Stroke DVD	< 200 ms (seek)
		Full Stroke CD	< 200 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC -< 800 mA typical, <1600 mA maximum
	Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
	(all conditions non-	Relative Humidity	10% to 80%
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
	Operating Systems Supported	Windows 10, Windows 7 Profession Red Hat® Enterprise Linux®(RHEL) V SUSE Linux® Enterprise Desktop 10	WS4**, 5, 6 Desktop/Workstation
		* No driver is required for this device. Native support is provided by the operating system.	
	Kit Contents	HP SATA DVD Writer drive, installat	ion guide.
HP 9.5mm Slim DVD-ROM Drive	Description Mounting Orientation Interface Type	9.5mm height, tray-load Either horizontal or vertical SATA / ATAPI	



	Dimensions (WxHxD) Disc Capacity	128 x 9.5 x 127mm DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB
	Access Times	DVD-ROM Single Layer CD-ROM Mode 1 Full Stroke DVD	< 110 ms (typical) < 110 ms (typical) < 230 ms (typical)
	Power	Full Stroke CD Source DC Power Requirements DC Current	< 220 ms (typical) SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p 5 VDC – <800mA typical, < 1600 mA
Operating Environmental (all conditions non- condensing) Operating Systems	Temperature Relative Humidity Maximum Wet Bulb Temperature Windows 10, Windows 7 Profession	maximum 41° to 122° F (5° to 50° C) 10% to 80% 84° F (29° C) nal 64-bit	
	Supported	Red Hat [®] Enterprise Linux [®] (RHEL) SUSE Linux [®] Enterprise Desktop 10 No driver is required for this device operating system.	WS4**, 5, 6 Desktop/Workstation) & 11
	Kit Contents	9.5mm Slim DVD-ROM Drive, 5.25" data/power cable, installation guid	ODD Bay adapter/carrier, slim SATA le
HP HH DVD Writer (16X	Description	HP Half Height DVD Writer	
RW DVD-R)	Mounting Orientation	Either Horizontal or vertical	
	Interface Type	SATA	
	Dimensions (WxHxD)	146x42x165mm	
	Supported Media Types	DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
		Full Stroke DVD	145ms (seek)
		Full Stroke CD	120ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read	DVD+RW Up to 13X DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X DVD-ROM DL Up to 12X



	Power Operating Environmental (all conditions non- condensing) Operating Systems Supported	Source DC Power Requirements DC Current Temperature Relative Humidity Windows 10, Windows 7 Profession WS4**,5,6 Desktop/Workstation. No driver is required for this device, operating system.	
	Kit Contents	HP SATA DVD Writer drive, Installat	ion guide.
HP 9.5mm Slim BDXL Blu- Ray Writer	Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types	9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm BD-ROM	
		BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	DVD-ROM Blu-ray	8.5 GB DL or 4.7 GB standard 25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL)
		Full Stroke DVD	< 230 ms (seek)
		Full Stroke CD	< 220 ms (seek)
		Blu-ray	< 230 ms (seek) (Full Stroke Blu-ray)
		Startup Time	(Time to drive ready from tray loading) BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S DVD-RW 25S DVD-RW 25S DVD+R (SL/DL) 25S / 25S DVD+RW 25S



			CD-ROM 15S	
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X	
		DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X	
		Blu-ray	BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X	
	Power	Source	SATA DC power receptacle	
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p	
	Operating Environmental (all conditions non-	DC Current	5 VDC -900 mA typical, 2000mA maximum	
		l Temperature	41° to 122° F (5° to 50° C)	
		Relative Humidity	10% to 80%	
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)	
	Operating Systems Supported	Windows 10, Windows 7 Professional 64-bit Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation SUSE Linux® Enterprise Desktop 12		
Kit Contents		No driver is required for this device. Native support is provided by the operating system.		
	Kit Contents	9.5mm Slim BDXL Blu-Ray Writer, 5 SATA data/power cable, installatio	5.25" ODD Bay adapter/carrier, slim n guide	
		As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.		
HP SD Card Reader	Description	Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports SD 4-bit parallel transfer mode		
	Interface Type	USB 3.1 GEN 1 High-speed interfac		
	Dimensions (WxHxD)		15 mm) Fits conveniently in the Front IO	
	Supported Media Types	Secure Digital Card (SD) Secure Digital High Capacity (SDHC SD Extended Capacity Memory Card		



	SD Ultra High Speed II(SD UHSII)
	These additional media types are supported with a card adapter. Memory Stick Micro (M2) miniSD miniSD High Capacity Micro SD Memory Card (MicroSD) Micro SD High Capacity Memory Card (MicroSDHC)
	Test Parameters/Conditions - Power applied, unit operating on system ±5%
Operating Systems Supported	Windows 10
	No driver is required for this device. Native support is provided by the operating system.
Kit Contents	Media card reader
Approvals	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0,
	Compliant Intel® Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT
Weight	0.35 lbs. (0.16 kg)



Technical Specifications - Controller Cards

CONTROLLER CARDS

HP Thunderbolt-3 Dual Port2 PCIe 1-port I/O	Data Transfer Rate Devices Supported	Supports up to 40 Gb/s (40,000 Mb/s) Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows
Card		devices
	Bus Type	PCIe card, full height PCIe slots
	Ports	Two Thunderbolt™ 3 external USB type-C output connectors (Rear) Two full size DisplayPort input connectors (Rear)
	Internal Connectors	One 2x5-Pin header connector
	System Requirements	Windows 10 Professional 64-bit, available dedicated PCH PCIe slot.
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	-22° to 140° F (-30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Windows 10 Professional 64-bit.
	Kit Contents	HP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO (General-Purpose Input/Output) cables, Installation documentation and warranty card.

*Maximum speed requires DisplayPort[™] and PCIe aggregation.

NETWORKING AND COMMUNICATIONS

Integrated Intel® I219LM	Connector	RJ-45
	Controller	Intel [®] I219LM
	Data Rates Supported	10/100/1000 Mbps
	Boot ROM Support	PXE, UEFI
	Connect Speed LED	Link/Activity LED
	Indicators	• Off = No link
		 Blinking = Activity
		Speed LED
		 Off = 10Mbps
		 Amber = 100Mbps
		 Green = 1000Mbps

Management Capabilities Intel[®] Active Management Technology™ 11

Integrated Intel® V722	Connector	1 RJ-45
Integrated Intel® X722 for 1GbE	Controller	Intel® X722 for 1GbE
	Data Rates Supported	1000 Mbps
	Boot ROM Support	PXE, UEFI
	Connect Speed LED Indicators	Link/Activity LED • Off = No link
	marcators	 Blinking = Activity
		Speed LED
		• Off = No Link
		• Green = 1000Mbps
	Management Capabilities	s Wake-On-LAN
HP Z Dual 10GbE Network	Networking Interface	2 RJ-45
Module	System Interface	Cabled from Dedicated Rear I/O Slot
	Networking Speeds Supported	1Gbps, 10Gbps
	Cabling (up to 100m)	Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps
	Power Consumption (active-typical)	5.5W at 1Gbps 11.2W at 10Gbps
	Physical Dimensions	0.875 in x 3 in x 2.75 in
	Connect Speed LED	Link/Activity LED
	Indicators	• Off = No link
		Blinking = Activity
		Speed LED
		 Amber = 1Gbps Green = 10Gbps
	Operating Temperature	

Intel® I210-T1



	System Interface	PCI Express 2.1 x1
	Networking Speeds Supported	10Mbps, 100Mbps, 1Gbps
	Cabling (up to 100m)	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps
	Power Consumption (active-typical)	0.81W
	Physical Dimensions	Length: 6.7cm (2.64 inches) (Bracket) Width: 1.8cm (0.709 inches) Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches)
	Connect Speed LED Indicators	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps
	Operating Temperature	0 °C to 55 °C (32 °F to 131 °F)
	Hardware Certifications	USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003
Intel® I350-T2	Networking Interface	2 RJ-45
	System Interface	PCI Express 2.1 x4
	Networking Speeds Supported	10Mbps, 100Mbps, 1Gbps
	Cabling (up to 100m)	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps
	Power Consumption (active-typical)	4.4W
	Physical Dimensions	Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)
	Connect Speed LED Indicators Operating Temperature	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps 0 °C to 55 °C (32 °F to 131 °F)
	operating reinperature	



		Communications	
	Hardware Certifications	USA: FCC B,	
		EU: UL CE,	
		Japan: VCCI, Taiwan: BSMI	
		Taiwan: BSMI, Australia/New Zealand: CTICK,	
		Korea: KCC,	
		Canada: ICES-003/NMB-003	
Intel® 1350-T4	Networking Interface	4 RJ-45	
	System Interface	PCI Express 2.1 x4	
	-	•	
	Networking Speeds Supported	10Mbps, 100Mbps, 1Gbps	
	Cabling (up to 100m)	Cat3 (or higher) for 10Mbps	
		Cat5 (or higher) for 100Mbps	
		Cat5e (or higher) for 1Gbps	
	Power Consumption (active-typical)	5W	
	Physical Dimensions	Length: 13.54cm (5.33 inches)	
		Width: 6.89 (2.71 inches)	
		Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)	
	Connect Speed LED	Link/Activity LED	
	Indicators	• Off = No link	
		• Blinking = Activity	
		Speed LED	
		• Off = 10Mbps	
		Green = 100Mbps	
		• Amber = 1Gbps	
	Operating Temperature	0 °C to 55 °C (32 °F to 131 °F)	
	Hardware Certifications	USA: FCC B,	
		EU: UL CE, Japan: VCCI,	
		Taiwan: BSMI,	
		Australia/New Zealand: CTICK,	
		Korea: KCC,	
		Canada: ICES-003/NMB-003	
Aquantia® AQN-108	Networking Interface	RJ-45	
•	System Interface	PCI Express 3 x1	
	Networking Speeds	100Mbps, 1Gbps, 2.5Gbps, 5Gbps	
	Supported	1001.0003, 10003, 2.30003	
	Cabling (up to 100m)	Cat5e (or higher) for all speeds	
	Power Consumption (active-typical)	3.5W at 5Gbps, 3.0W at 2.5Gbps	
	Physical Dimensions	3.72 in x 3.18 in (without bracket)	



	Connect Speed LED Indicators Operating Temperature Hardware Certifications	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = No link • Amber = <5Gbps • Green = 5Gbps	
		0°C to 55°C (32°F to 131°F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003	
Intel® X550-T2	Networking Interface	2 x RJ-45	
	System Interface	PCI Express 3 x4	
	Networking Speeds Supported	100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps	
	Cabling (up to 100m)	Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6a (or higher) for 10Gbps	
	Power Consumption (active-typical)	3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps	
	Physical Dimensions	5.2 in x 2.7 in (without bracket)	
	Connect Speed LED Indicators	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = No link • Amber = <10Gbps • Green = 10Gbps	
	Operating Temperature	0 °C to 55 °C (32 °F to 131 °F)	
	Hardware Certifications	USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003	
Intel® X710-DA2	Networking Interface	2 SFP+ Ports for LC SFP+ Transceivers	

Intel® X710-DA2 10GBASE-SR Converged Network Adapter

Networking Interface System Interface Networking Speeds Supported 2 SFP+ Ports for LC SFP+ Transceivers PCI Express 3.0 x8 1Gbps, 10Gbps



System Interface

Antenna

	6.1 P			
	Cabling Down Communities	LC fiber optic cabling with LC SFP+ Transceivers		
	Power Consumption (active-typical)	4.3W		
	Physical Dimensions	6.578 in x 2.703 in		
	Connect Speed LED Indicators	Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps		
	Operating Temperature	0 °C to 55 °C (32 °F to 131 °F)		
	Hardware Certifications	USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003		
	Note: Windows 7 is NOT supported			
10GbE SFP+ SR	Connector Type	LC		
Transceiver	Cable Type	62.5/125um or 50/125um (core/cladding), graded-index, low metal content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC 793-2 Type A1b or A1a, respectively.		
	Cable Length	2-300m		
	Wavelength	850nm		
	Form Factor	SFP+		
	Physical Dimensions	0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm)		
	Operating Temperature	OC to 45C (32F to 113F)		
	Operating Humidity	0% to 85%, noncondensing		
Intel® 8265 WLAN	Networking Speeds	802.11ac MU-MIMO (up to 867 Mbps) Bluetooth 4.2		
	IEEE WLAN Standard	IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending		
		002.111, 002.11X, 002.11V pending		



PCI Express 2.1 x1

2x2

Summary of Changes

SUMMARY OF CHANGES

Date of change:	Version History:		Description of change:
November 1, 2017	From v1 to v2	Added	HP DisplayPort to HDMI Adapter, HP DisplayPort to VGA Adapter, NVIDIA SLI 3-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section and Microsemi 3152-8i SAS ROC RAID Controller
		Changed	Graphics, Storage / Hard Drives and Memory sections, changed Front and internal view info on the Overview section, changed Operating Systems section, changed System Board section, Physical Security and Serviceability sections
November 29, 2017	From v2 to v3	Added	Processors, hard drives and graphics to offerings, added Declared Noise Emissions information
January 30, 2018	From v3 to v4	Removed	NVIDIA SLI Graphics Connectors from Graphics Cable Adapters section
March 27, 2018	From v4 to v5	Added	Intel Xeon processors added
April 16, 2018	From v5 to v6	Removed	RAID 5
August 13, 2018	From v6 to v7	Added	Footnote to Networking and Communications section
		Changed	Processors section and Operating Systems section
September 4, 2018	From v7 to v8	Removed	HP IEEE 1394b FireWire PCIe Card
September 6, 2018	From v8 to v9	Removed	Microsemi 3152-8i SAS ROC RAID Controller
September 21, 2018	From v9 to v10	Added	Intel Optane SSD 905p AiC 280GB & 480GB
September 26, 2018	From v10 to v11	Changed	NVIDIA Quadro P6000 Graphics specs
April 8, 2019	From v11 to v12	Added	New Intel Xeon Processors and graphics, added HP DX175 Removable HDD Carrier into the HDD Frame/Carriers section
		Changed	Storage / Hard Drives, Memory sections and format changes
May 15, 2019	From v12 to v13	Added	NVIDIA Quadro RTX 8000 48GB Graphics
		Changed	External BIOS simulator link on Physical Security and Serviceability section
		Removed	Intel 9260 WLAN
June 12, 2019	From v13 to v14	Changed	Storage section
July 7, 2019	From v14 to v15	Added	Intel Xeon W Processors
July 15, 2019	From v15 to v16	Changed	Corrected Intel 905p Series AIC 480GB PCIe SSD
August 1, 2019	From v16 to v17	Changed	Processors Matrix
September 1, 2019	From v17 to v18	Added	Footnote to Memory section, Added Optane 905P 380GB M.2 SSD Module, HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section
October 26, 2019	From v18 to v19	Changed	Graphics section
November 1, 2019	From v19 to v20	Added	NVDIMM Memory sections, Added HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section
January 2, 2020	From v20 to v21	Changed	Storage section
February 26, 2020	From v21 to v22	Added	New Intel Xeon Processors
		Changed	Overview, PCIe Solid State Drives sections

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